ODU MINI-SNAP® L

ODU MINI-SNAP® B

ODU MINI-SNAP® F

ODU AMC°

ODU MEDI-SNAP®





ODU MINI-SNAP® PC

ODU MINI-SNAP® K

FEATURES

- · Quick and easy mating and demating
- · Blind mating and demating in difficult-to-reach places
- Low space requirements on the receptacles
- · Definite and secure locking conditions
- · Robotic mating and demating possible
- Easy cleaning of the connector plug housing possible
- · High connector density
- · Low power requirement

APPLICATIONS

- Medical
- Industrial
- Test and measurement
- · Military and security
- Energy
- eMobility



All shown connectors are according to IEC 61984:2008 (VDE 0627:2009); connectors without breaking capacity (COC).

ODU MINI-SNAP is UL-approved under file E110586. MIL specification: Tests carried out (see page 170).

All dimensions are in mm.

Some figures are for illustrative purposes only.
Subject to change without notice. Errors and omissions excepted.
We reserve the right to change our products and their technical specifications at any time in the interest of technical improvement.
This publication supersedes all prior publications.

This publication is also available as a PDF file that can be downloaded from ${\bf www.odu\text{-}connectors.com}.$

Issue: 2018-05

Data transmission protocols

These ODU specific connectors can transmit common data transmission protocols such as USB® 2.0, USB® 3.1 Gen1, CAT 5, CAT 6_λ and Ethernet , but they are not USB®-, CAT- and Ethernet-standard connectors.

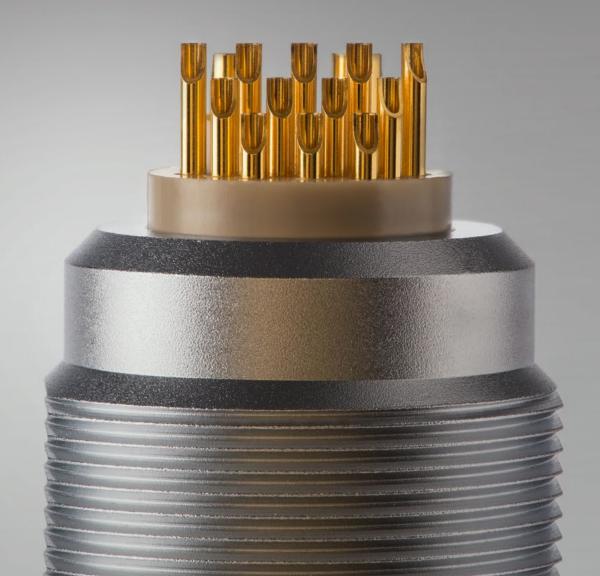
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 $For assembly instructions, please \ refer \ to \ our \ website: \\ \underline{www.odu-connectors.com/downloads/assembly-instructions}$

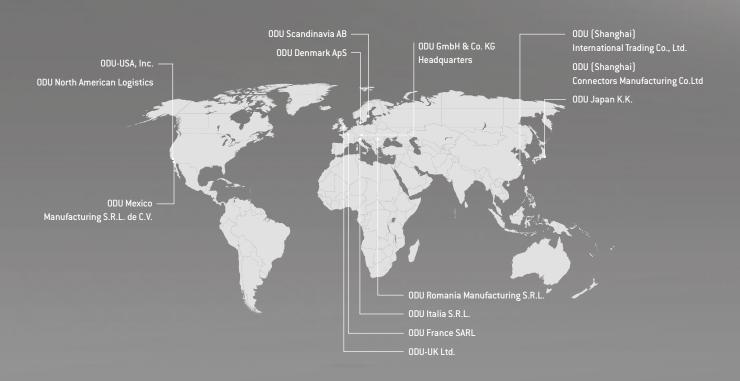
APERFECT ALLIANCE.

CREATING CONNECTIONS, BUILDING ALLIANCES, COLLABO-RATING INTO THE FUTURE: WHETHER TWO TECHNICAL COMPONENTS COME TOGETHER TO FORM A UNIT OR PEOPLE COME TOGETHER TO STRIVE FOR GREAT RESULTS — THE KEY IS TO ASPIRE IN ACHIEVING SUPERB RESULTS. THIS GOAL DRIVES OUR WORK. PERFECT CONNECTIONS THAT INSPIRE AND DELIVER ON THE PROMISES.





ODU WORLDWIDE



ODU GROUP OVERVIEW

- More than 75 years of experience in connector technology
- A turnover of 170 million Euro
- Over 1,900 employees worldwide
- 9 sales subsidiaries in China, Denmark, France, Germany, Italy, Japan, Sweden, the UK and the US as well as
 5 production and logistics sites
- All technologies under one roof: Design and development, machine tool and special machine construction, injection, stamping, turning, surface technology, assembly and cable assembly

As of February 2018

CERTIFIED QUALITY

- DIN EN ISO 9001
- IATF 16949
- DIN EN ISO 14001
- ISO 13485
- Wide range of UL, CSA, VG and DVA licenses
- UL certified cable assembly

For a complete list of our certifications, please visit our website.

ODU'S PRODUCT PORTFOLIO.





COMPACT MODULAR CONNECTOR SOLUTIONS

- Application-specific hybrid interface
- For manual mating and automatic docking
- The highest packing density
- Flexible modular construction
- Multitude of data transmission modules
- · Variety of locking options available
- For the transmission of signals, power, high current, high voltage, coax, high-speed data, fiber optics and other media such as air or fluid.
- Mating cycles scalable as required from 10,000 to over 100,000 (1 million)



PUSH-PULL CIRCULAR CONNECTORS

- · Circular connector series in robust metal or plastic housing
- Contacts for soldering, crimping and PCB termination
- Optional selectable Push-Pull locking ensuring a secure connection at all times as well as easy to release Break-Away function
- 2 up to 55 contacts
- · Autoclavable for medical applications
- Hybrid inserts for combined transmission



ELECTRICAL CONTACTS

- · Versatile connector technologies
- · Outstanding reliability, lifetime and durability
- Up to 1 million mating cycles
- Current-carrying capacity of up to 2,400 amperes and more
- Rugged contact systems, suitable even for harsh environments
- · Economical solutions for automatic processing





HEAVY-DUTY & DOCKING AND ROBOTIC CONNECTOR SOLUTIONS

- Extremely durable even under extreme / harsh environments
- Interference-free and secure connection, even under vibration
- Up to 500 A (higher currents upon request)
- High contact security due to the springwire technology
- High pin density due to a minimum contact
 diameter.
- Low contact resistance



APPLICATION AND CUSTOMER-SPECIFIC SOLUTIONS

- Contacts, connectors and assemblies for the highest technical requirements as well as special applications
- First-class implementation expertise
- High level of vertical manufacturing all competences and key technologies under one roof
- Expert advice based on mutual partnership
- Fast development and production



CABLE ASSEMBLY

- Complete systems from a single source based on years of assembly expertise
- State-of-the-art production facilities with 100% end testing, high-voltage testing, component testing and pressure testing up to 100 bar
- Cleanroom production
- Hot-melt and high-pressure injection molding
- Customer-specific labeling
- Rapid prototyping of samples



HIGH PERFORMANCE CONNECTOR TECHNOLOGY FOR DEMANDING KEY MARKETS

Customers rely on ODU technology wherever first-class, high-performance connector solutions are required. All our skills go into our products to ensure your success. In addition to the top quality, reliable stability and maximum flexibility in customer-specific requirements, our products also stand for dynamics, reliability, safety, precision, efficiency and sustainability. And they guarantee unrestricted functionality for the final product due to our high quality connectors. ODU — A PERFECT ALLIANCE.

APPLICATION-SPECIFIC SOLUTIONS

Demands that can't be pigeon-holed call for creative specialists who think outside the box. ODU offers the type of expertise that focuses solely on the specific requirements of our customers. For every development order we get, we not only perform a thorough check to make sure it's feasible, we intensively incorporate our customers in the ongoing design process. This guarantees an impressive, custom-fit final result. Our solutions are frequently based on the modifications of our products, especially for the ODU MINI-SNAP and ODU-MAC connectors.



HIGH LEVEL OF VERTICAL INTEGRATION

ODU combines all the competences and key technologies for the connector manufacturing. These include design and development, machine tool and special machine construction, injection, stamping, turning, surface technology, assembly and cable assembly and our own test laboratory.

INDIVIDUAL CABLE ASSEMBLY

Our production skills together with our cutting edge production facilities from Europe, China and the USA enable us to deliver to our customers locally tested assemblies and also global ones.



ODU MINI-SNAP®



PRODUCT INFORMATION

rush-ruil connector series at a giance	. 12
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THE COMPLETE SERIES OF ODU PUSH-PULL **CONNECTORS AT A GLANCE**

	Keying	Size	No. of possible me- chanical keyings	Plug diameter in mm	Max. cable diameter in mm	Number of max. contacts	Solder	Crimp	PCB	IP protection degree IEC 60529:2013 in mated condition	IP protection degree IEC 60529:2013 in unmated condition	From page
ODU MINI-SNAP® L		00	4	6.4	3.5	04						
		0	8	9	5.6	10					Up to IP 68	
- (Park)	o 9	1	8	11.5	7.7	16				IP 50		22
	groov	2	8	14.5	9.9	26						<u> </u>
	Pin and groove	3	8	17.5	11.9	30						
	Pi	4	8	25	16	40						
ODU MINI-SNAP® K		0	8	11	5	10						
	, e	1	8	13	7	16						
E a a same	Pin and groove	2	8	16	9	26	•	•	•	Up to IP 68	Up to IP 68	<u>74</u>
	and	3	8	19	10.5	30						
	Ë	4	8	25	14	40						
ODU MINI-SNAP® B	á	0	8	9.4	5	10						
	Pin and groove	1	9	12	7	16				IP 68	Up to	
	and §	2	10	15	9	26				מס דו	IP 68	<u>114</u>
	Pi	3	13	18	10.5	30						

FURTHER PRODUCTS OF THE ODU PUSH-PULL CONNECTOR SERIES.







ODU MINI-SNAP® F



ODU MINI-SNAP® S





- Push-Pull locking
- Break-Away functionality
- Distinctive coding options - by colors and mechanics
- Lightweight
- 2 to 26 positions
- IP 50, IP 64 and IP 67
- Sterilizable versions
- 2,000 mating cycles
- Keying over half-shell
- 2–27 contacts
- Low weight
- IP 67
- 3 sizes
- Plastic connector plug housing
- Keying over half-shell
- 2-27 contacts/ mixed inserts
- 5 sizes
- IP 50 and IP 68 with same IP 50 and IP 68 with same outer diameter possible
- Contacts for solder, crimp and PCB termination
- Keying over insulator
- 2-10 contacts/ mixed inserts
- 3 sizes
- outer diameter possible
- Contacts for solder, crimp and PCB termination
- Push-Pull and Break-Away version
- 3-55 contacts
- 6 sizes
- Watertight IP 68
- Easy-Clean and High-Density version
- Tested acc. MIL
- Low weight (aluminium connector plug housing)

CIRCULAR CONNECTORS WITH PUSH-PULL LOCKING IN METAL CONNECTOR PLUG HOUSING



ODU MINI-SNAP is the ideal self-locking circular connector for a wide range of applications. Whether used for transmitting power, signals, data or other media, this circular connector in its robust metal connector plug housing impresses customers with its exceptional quality, high reliability and ideal handling characteristics.

The Push-Pull principle reliably ensures that the connector will not come loose during application in practice: Once plugged in, the ODU MINI-SNAP locks itself into the receptacle automatically. It cannot be separated by pulling on the cable. Instead, the connector can easily be separated from the receptacle by pulling on the outer housing.

The ODU MINI-SNAP is available in a wide range of sizes and models. In addition, you can choose between three base codings.

VERSATILE CONFIGURATION OPTIONS

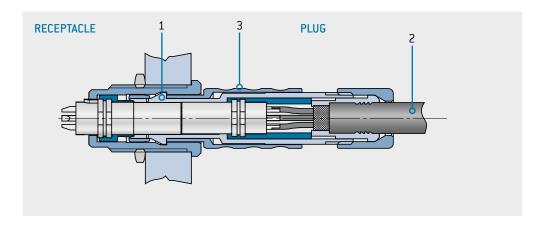
There are 6 sizes, 3 termination types and a great variety of various contact inserts to choose from.

FUNCTIONAL PRINCIPLE OF THE PUSH-PULL LOCKING

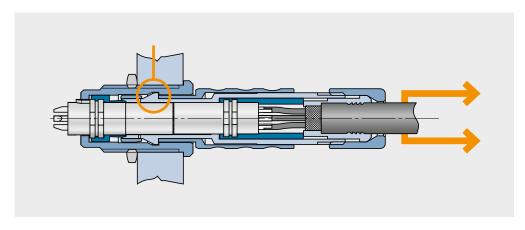
Push-Pull locking systems have a highly user-friendly locking mechanism. When the connector is mated with the receptacle, the connector's locking fiegers (1) will lock into place in the receptacle and form a dependable connection between both parts. It cannot be separated by pulling on the connector's cable (2). Instead, the connector can easily be separated from the receptacle by pulling on the outer housing (3). Push-pull connectors from ODU are available in 6 different standard sizes with diameters from 6.4 mm to 25 mm.

You can read about the precise functioning of the locking mechanism in the relevant series.

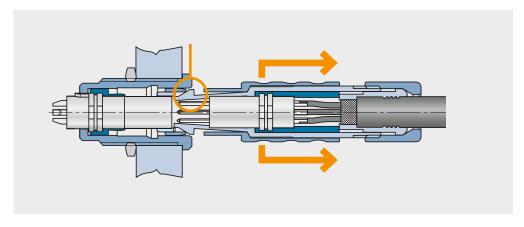
Connector in **mated** condition



Pulling on the cable or back nut will lock the "fi gers" firm y in place in the receptacle's locking groove. This prevents the connector from being disconnected.



But pulling on the outer housing will cause the fi gers to emerge from the locking groove, making it easy to disconnect the connector.



IMPORTANT ISSUES AT A GLANCE

VARIOUS SIZES

- Metal connector plug housing deliverable in 6 sizes
- Outer diameter 6.4 mm to 25 mm
- Number of contacts 2 to 40 contacts, mixed inserts
- IP 50 and IP 68 are deliverable.

APPLICATIONS AND MATERIALS

The ODU MINI-SNAP uses PEEK insulator material as a standard feature. Other materials are available upon request. ODU MINI-SNAP connector plug housings are made of brass, nickel plated and then matt chrome plated. Nickel and black chrome plated connector plug housings are available upon request as special materials. The internal parts are made of nickel-plated brass.

Thanks to its versatility and autoclavability, the ODU MINI-SNAP is used in a wide range of fields, such as medical technology, measurement and testing technology, military and security technology, industrial electronics and energy technology.

The temperature of ODU MINI-SNAP range under general conditions of use runs from $-40\,^{\circ}\text{C}$ to $+120\,^{\circ}\text{C}$, while autoclavable connectors can even be used at temperatures up to $+134\,^{\circ}\text{C}$ (see page $\underline{170}$).

TURNED CONTACTS

Turned contacts are available in diameter 0.5 mm to 2 mm in the following termination types:

Solder, crimp and PCB

Mating cycles > 5.000
Material Brass
Plating Ni and Au

TERMINATION TECHNOLOGIES

	Plug	Receptacle
Crimp termination	•	•
Solder termination	•	•
PCB termination	•	•

STANDARD PIN CONTACTS



Information on diameters, terminal types and currentcarrying capacity can be found in the relevant series after the inserts.



ODU MINI-SNAP®



Correct configuring – step by step

BIT BY BIT TO THE PERFECT CONNECTION

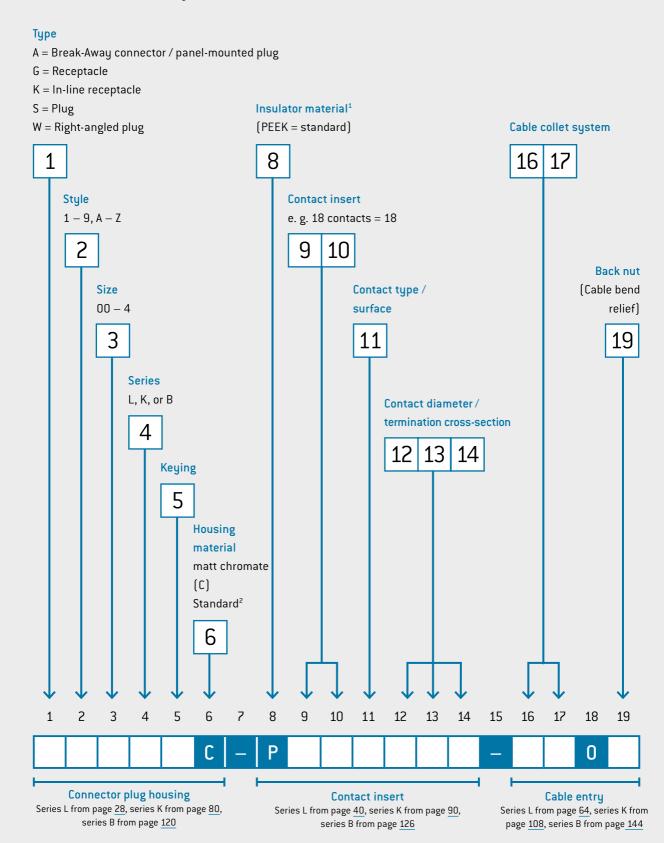
ODU offers you high-quality connectors and comprehensive service for the complete assembly. From connectors to watertight grouting, we provide the complete system from a single source.



YOUR WAY TO AN INDIVIDUAL CONNECTION:

HOW TO CONFIGURE WITH THE PART NUMBER KEY

This shows you how ODU's part number key is composed. In the fir t part of the configuration, select the connector plug housing (such as style and size) of the connector. In the middle part of the part number key, you configure the contact insert and then the cable entry.



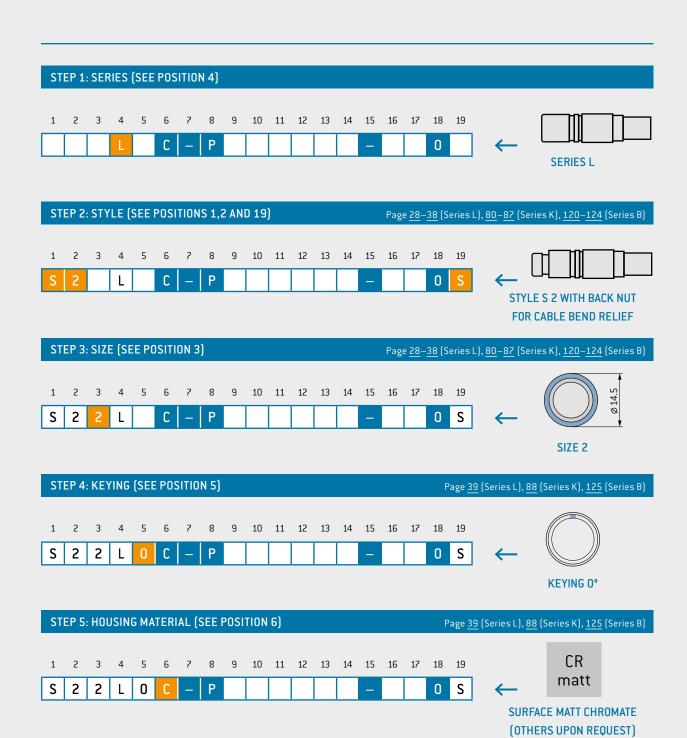
¹ Other insulation materials on request. ² Black chrome plated on request.

SAMPLE CONFIGURATION STEP BY STEP

The perfect product for you in just a few steps. These stepby-step instructions show you how to configure your own individual product with the ODU part number key based on a sample configuration.



Connector in style 2 / size 2 / series L / keying 0° / connector plug housing Ms matt chrome plated / insulator PEEK / 16 contacts / pin (solder) Au / termination cross-section AWG 22 / cable diameter 6–7.2 mm / back nut for silicone cable bend relief (silicone cable bend relief has to be ordered separately)

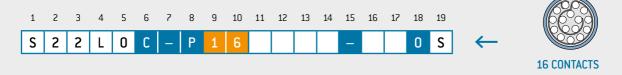


STEP 6: INSULATOR MATERIAL (SEE POSITION 8) 1 2 3 4 5 6 7 8 9 10 11 12 13 14 15 16 17 18 19 S 2 2 L 0 C - P - 0 S



STEP 7: CONTACT INSERT (SEE POSITIONS 9 AND 10)

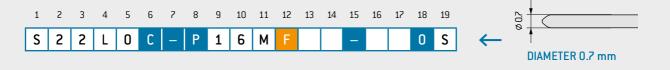
Page $\underline{40} - \underline{60}$ (Series L), $\underline{90} - \underline{104}$ (Series K), $\underline{126} - \underline{140}$ (Series B)



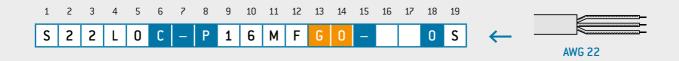




STEP 9: CONTACT DIAMETER (SEE POSITION 12)

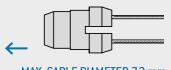


STEP 10: TERMINATION CROSS-SECTION (SEE POSITIONS 13 AND 14)



STEP 11: CABLE COLLET SYSTEM (SEE POSITIONS 16 AND 17)





MAX. CABLE DIAMETER 7.2 mm MIN. CABLE DIAMETER 6 mm



ODU MINI-SNAP®



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SUMMARY ODU MINI-SNAP® SERIES K

The ODU MINI-SNAP Series K is keyed by pin and groove. These Push-Pull circular connectors can be configured in many different ways: a wide variety of sizes and termination types and contact inserts are available.

- Keying over pin and groove
- 2-40 contacts/mixed inserts
- Up to 5 sizes and 3 termination types
- Choice of numerous plugs and receptacles
- IP 68
- 5,000 mating cycles and more
- Contacts for solder, crimp and PCB termination

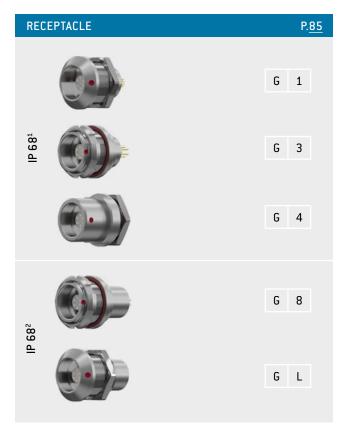






¹IP 68 when mated. ² IP 68 when mated or unmated.

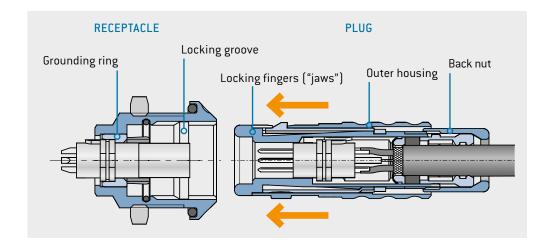




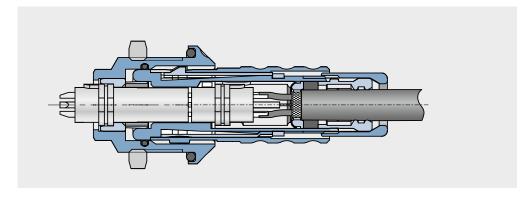
THE LP LOCKING PRINCIPLE SERIES K

Connector

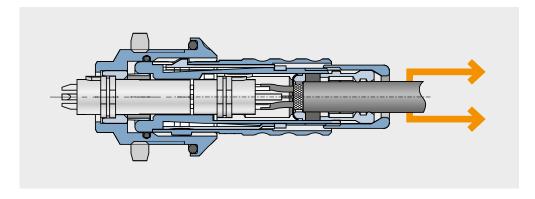
in **unmated** condition



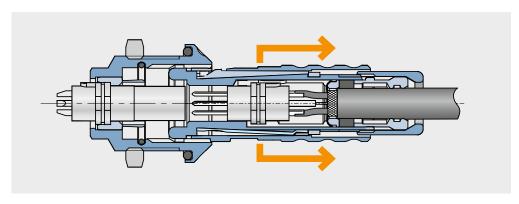
Connector in **mated** condition



Pulling on the cable or back nut will lock the "fi gers" firm y in place in the receptacle's locking groove. This prevents the connector from being disconnected.

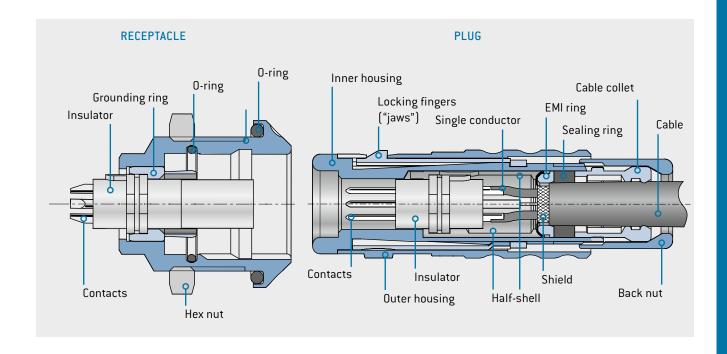


But pulling on the outer housing will cause the "fi gers" to emerge from the locking groove, making it easy to disconnect the connector.

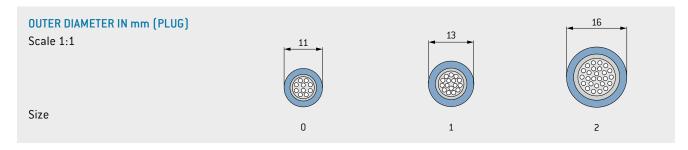


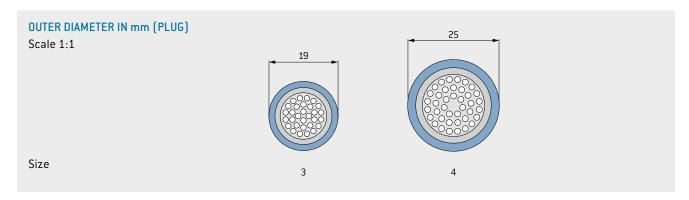
SERIES K

THE LP LOCKING SERIES K IN SECTIONAL VIEW



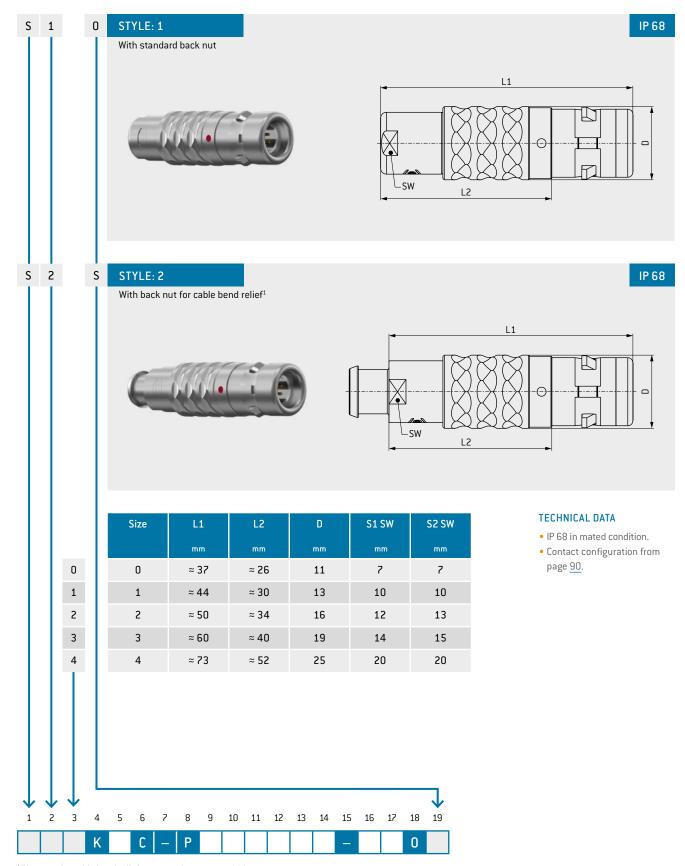
AVAILABLE SIZES





STRAIGHT PLUG

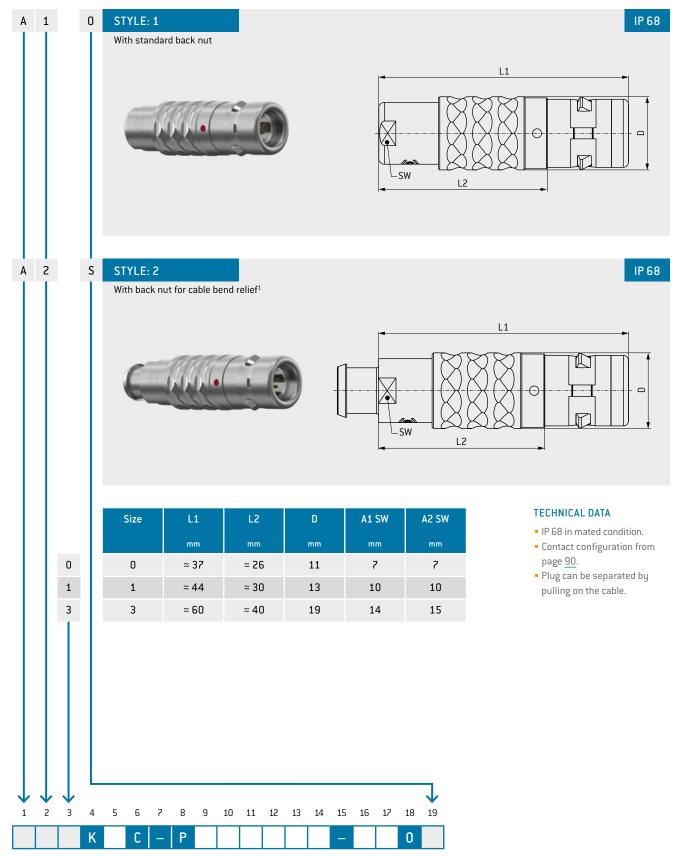




 $^{^{\}rm 1}\textsc{Please}$ order cable bend reliefs separately, see page 111.

BREAK-AWAY CONNECTOR



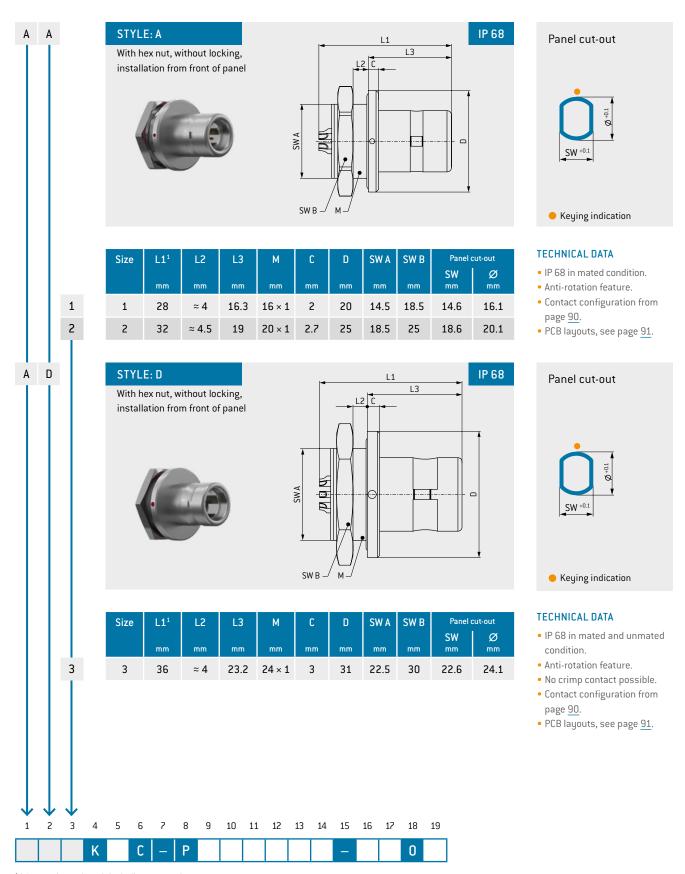


¹ Please order cable bend reliefs separately, see page 111.

PANEL-MOUNTED PLUG



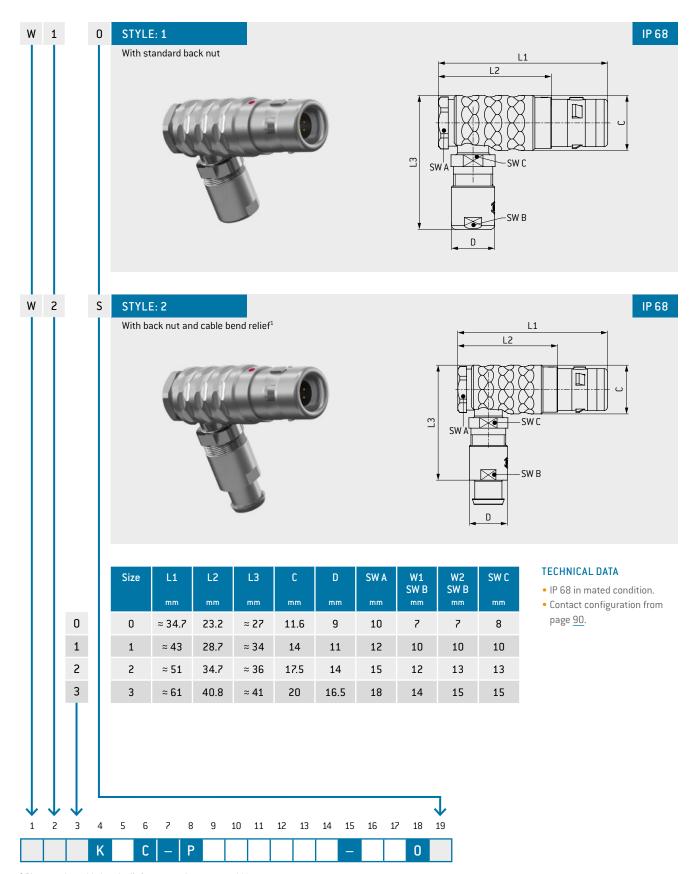
Suitable for creating a docking connection between 2 devices (e.g. a charging station).



 $^{^{1}}$ L1 = maximum length including contact insert.

RIGHT-ANGLED PLUG



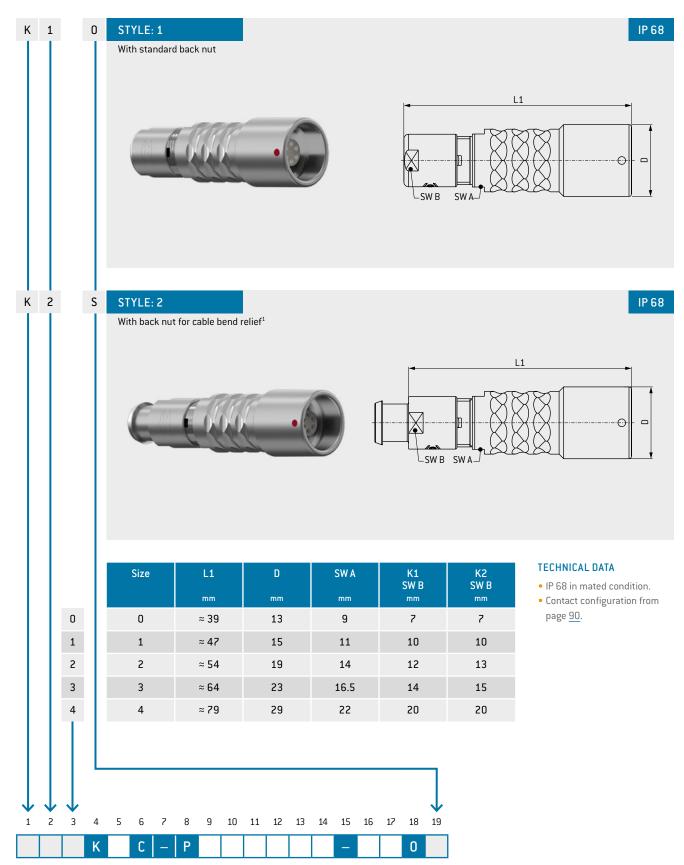


 $^{^{\}rm 1}$ Please order cable bend reliefs separately, see page $\underline{\rm 111}.$

IN-LINE RECEPTACLE



Suitable for creating a cable-cable connection.

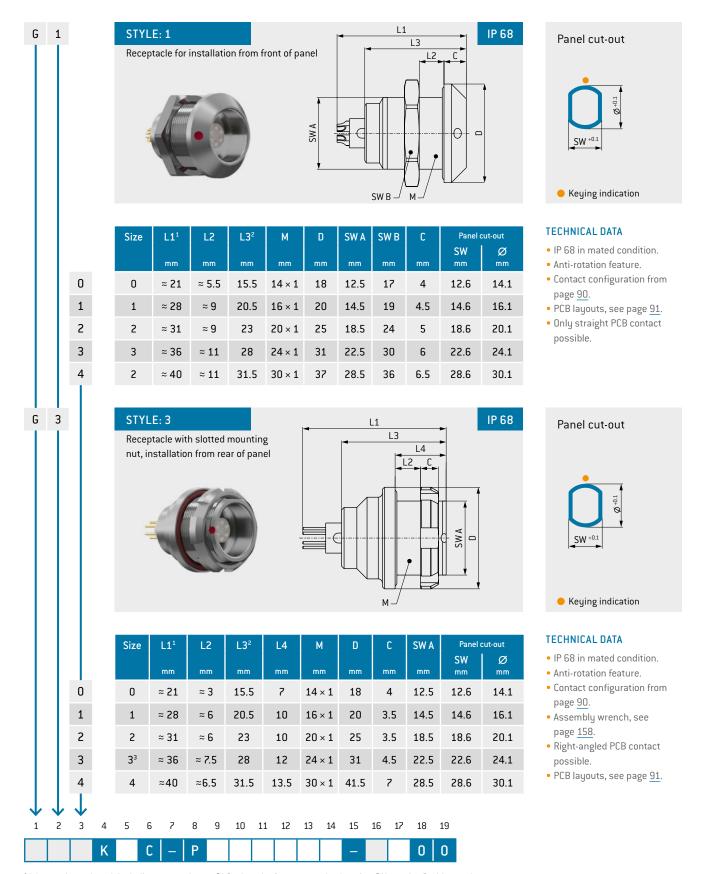


¹ Please order cable bend reliefs separately, see page <u>111</u>.

SERIES K

RECEPTACLE

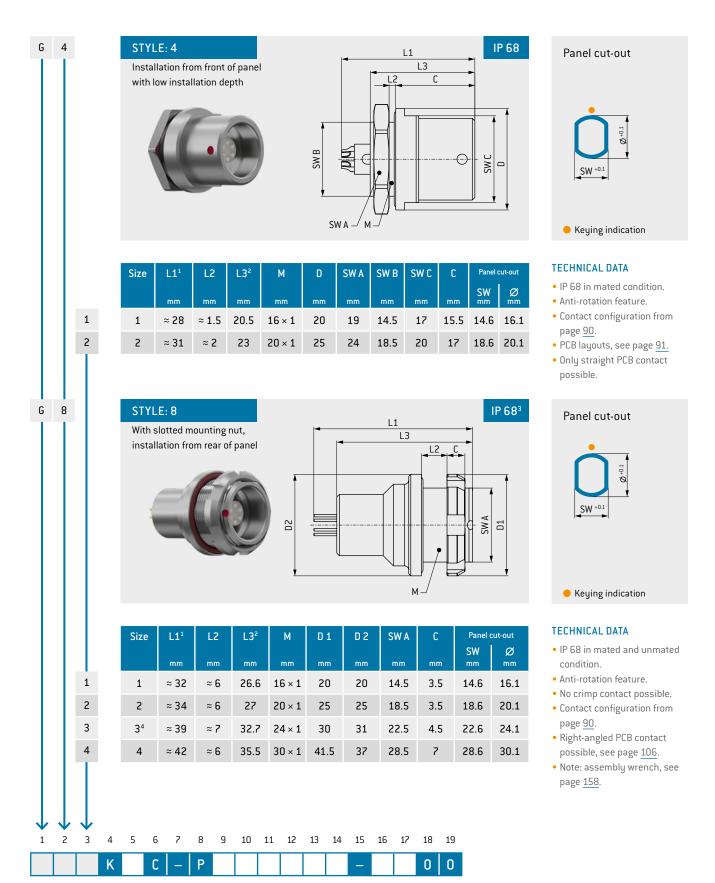




 $^{^1}$ L1 = maximum length including contact insert. 2 L3 = length of connector plug housing. 3 Note: size 3 with round nut.

RECEPTACLE





¹L1 = maximum length including contact insert. ²L3 = length of connector plug housing, ³ Note: tight, grouted receptacle, see page 163. ⁴ Note: size 3 with round nut.

SERIES K

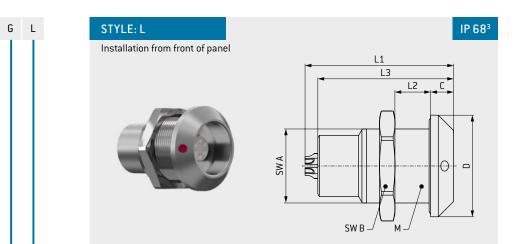
RECEPTACLE

0

1

2





Panel cut-out	
SW +0.1	
Keying indication	

Size	L1 ¹	L2	L3 ²	М	D	С	SW A	SW B	Panel o	cut-out
	mm	mm	mm	mm	mm	mm	mm	mm	SW mm	Ø mm
0	≈ 24	≈ 5	19.7	14 × 1	18	4	12.5	17	12.6	14.1
1	≈ 32	≈ 9	26.6	16 × 1	20	4.5	14.5	19	14.6	16.1
2	≈ 34	≈ 9	27	20 × 1	25	5	18.5	24	18.6	20.1

TECHNICAL DATA

- IP 68 in mated and unmated condition.
- Anti-rotation feature.
- Contact configuration from page <u>90</u>.
- No crimp contact possible.
- Only straight PCB contact possible.

1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19
			K		С	-	Р							-			0	0
¹ L1 =	maxi	mum	length	inclu	ding c	ontac	t inse	rt. ² L3	3 = ler	ngth o	f conn	ector	plug l	nousir	ng. ³ N	ote: ti	ght, gı	routed

ed receptacle, see page <u>163</u>.

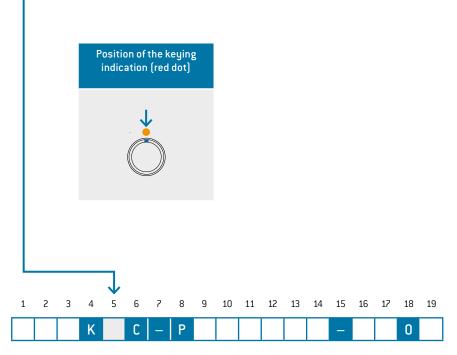
KEYINGS



Ang		Angle	Receptacle front view			Size		
			front view	0	1	2	3	4
0		0°		•	•	•	•	•
Α		30°		•	•	•	•	0
С		45°		•	•	•	0	0
F		60°		•	•	•	0	0
Н		75°		0	0	0	0	0
К		95°		0	0	0	0	0
Q		120°		0	0	0	0	0
W		145°		0	0	0	0	0

			ousir ateri										
С		Standard Cu-alloy / matt chromat											
S		On	requ	est	Cu-alloy / black chromate								
Special materials and surfaces on request.													
	3	4	5	6	7	8	9						
		K		С	_	Р							

• Standard o On request



FOR YOUR NOTES

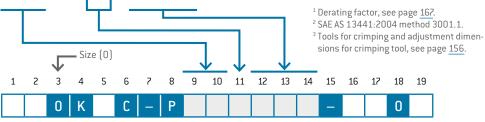
CONTACT INSERTS (SIZE 0)



C	nber of		tact t	ype 	Par	t num key	iber	Contact diameter	Single contact nominal		nd creepage ance	Test voltage ²	Nominal voltage ⁵	Termi- nation diameter		ination -section		w on tion area
cont	tacts	Termination	Socket	Pin				mm	current ¹	Contact to contact mm	Contact to housing mm	kVeff	kVrms	mm	AWG	mm²	Pin piece	Socket piece
		Solder	L	М	J	G	0		7.5	1	0.9	1.500	0.500	0.85	22	0.38		
0	2	Crimp ³	N	Р	J	Н	0	0.9	10	0.7	0.6	1.100	0.366	-	20-24	0.50-0.25		
U	۷	СППР	IN		J	G	0	0.5	7.5	1	0.9	1.500	0.500	-	22-26	0.38-0.15		
		PCB ⁴	Q	R	J	0	0		1.5	1	0.5	1.300	0.300	0.7	-	-		
		Solder	L	М	J	G	0		7.5	0.8	0.8	1.200	0.400	0.85	22	0.38		
0	3	Crimp ³	N	Р	J	Н	0	0.9	10	0.5	0.5	0.600	0.200	-	20-24	0.50-0.25		
U	3	СППР	IN	ľ	J	G	0	0.5	7.5	0.8	0.8	1.200	0.400	-	22-26	0.38-0.15		
		PCB ⁴	Q	R	J	0	0		1.5	0.0	0.0	1.200	0.400	0.7	-	-		
		Solder	L	М	F	G	0		7.5	0.6	0.6			0.85	22	0.38		
		Soluei	L	IVI	F	D	0		6	8.0	0.8			0.6	26	0.15		
0	4	Ci 3	N	Р	F	G	0	0.7	7.5	0.6	0.6	0.900	0.300	-	22-26	0.38-0.15		
		Crimp ³	IN	г	F	С	0		C	0.0	0.0			-	28-32	0.09-0.04		
		PCB ⁴	Q	R	F	0	0		6	0.8	0.8			0.5	-	-		
		Caldan			F	G	0		7.5	0.5	0.5	0.600	0.200	0.85	22	0.38		
		Solder	L	М	F	D	0		6	0.7	0.7	1.100	0.366	0.6	26	0.15		
0	5	C : 3		_	F	G	0	0.7	7.5	0.5	0.5	0.600	0.200	-	22-26	0.38-0.15		
		Crimp ³	N	Р	F	С	0			0.7	0.7	4.400	0.200	-	28-32	0.09-0.04		
		PCB ⁴	Q	R	F	0	0		6	0.7	0.7	1.100	0.366	0.5	-	-		
0	6	Solder	L	М	С	С	0	0.5	4	0.7	0.7	0.900	0.300	0.4	28	0.08		
U	0	PCB ⁴	Q	R	С	0	0	0.3	4	U.r	0.7	0.500	0.300	0.5	-	-		
0	7	Solder	L	М	С	С	0	0.5	4	0.7	0.7	0.900	0.300	0.4	28	0.08		
		PCB ⁴	Q	R	С	0	0							0.5	-	-		
0	9	Solder	L	М	С	С	0	0.5	4	0.4	0.7	0.600	0.200	0.4	28	0.08	699	689
		PCB ⁴	Q	R	С	0	0							0.5	-	-		
1	08	Solder	L	М	С	С	9	0.5	4	0.3	0.5	0.600	0.200	0.4	28	0.08		
		PCB ⁴	Q	R	С	0	9							0.5	-	-		

SPECIFIC INSERTS FOR HIGH DATA TRANSMISSION RATES

		Solder		М	F	G	0		7.5	0.6	0.6			0.85	22	0.38		
			_		F	D	0		6	8.0	8.0			0.6	26	0.15		Ethernet ^{6,9}
0	4	Crimp ³	NI.	Р	F	G	0	0.7	7.5	0.6	0.6	0.900	0.300	-	22-26	0.38-0.15		Type CAT 5 ⁹ up to 100 Mbit
		crimp-	IN	r	F	С	0		6	0.0	0.0			-	28-32	0.09-0.04		ap to 100 mil
		PCB ⁴	Q	R	F	0	0		ь	0.8	0.8			0.5	-	-		
U	4	Solder	-	М	F	G	0	0.7	7.5	0.6	0.6	0.900	0.300	0.85	22	0.38		USB® 2.0 ^{7, 9}
Ü	4	Crimp ³	-	Р	F	G	0	U.r	7.5	0.6	0.6	0.500	0.300	-	22-26	0.38-0.15		
		Solder	L	-	F	G	0							0.85	22	0.38		
0	4	Crimp ³	N	-	F	G	0	0.7	7 7.5 0.6 0.6	0.6	0.900	0.300	-	22-26	0.38-0.15		USB® 2.0 ^{7, 9}	
		PCB ⁴	Q	-	F	0	0							0.5	-	-		
															4			



- ⁴ PCB layouts, see page <u>91</u>. PCB termination only possible in the receptacle and panel-mounted plug
- ⁵ Max. operating voltage at NN (sea level) acc. to SAE AS 13441:2004 method 3001.1. Further information on page <u>168</u>.
- ⁶ ISO/IEC 11801:2017.
- Further information on request.
- ⁷ Acc. Universal Serial Bus 3.2 Spec.:2017. Further information on request.
- ⁸ Not compatible to competition.
- ⁹ Concerning data transmission protocols please note page <u>2</u>.

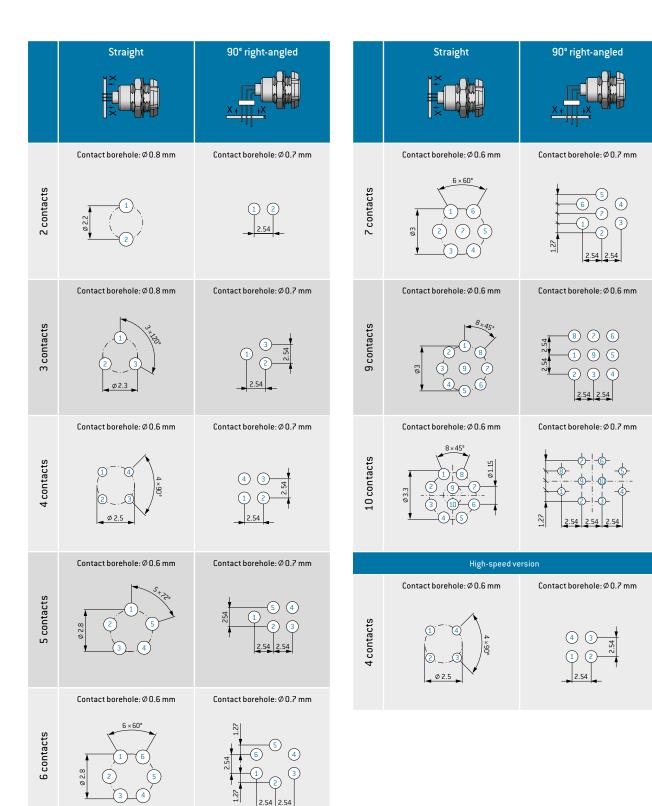
90

SERIES K

PCB LAYOUTS







All specifications are only valid for socket inserts.

Pin inserts on request. Further PCB layouts upon request.

CONTACT INSERTS (SIZE 1)



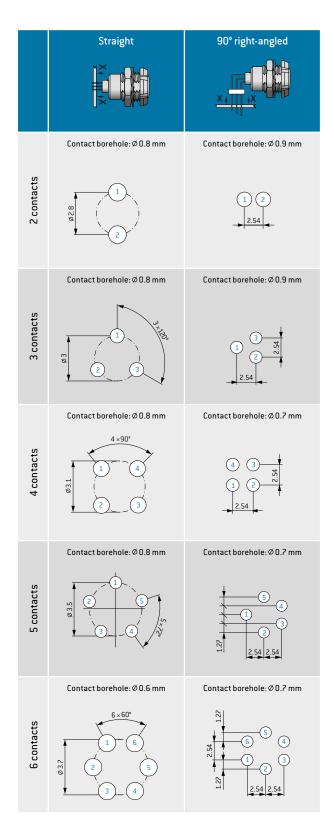
	nber of		tact t	ype 	Pa	rt num key	ber	Contact diameter	Single contact nominal		nd creepage ance	Test voltage ²	Nominal voltage ⁵	Termi- nation diameter		nation section		w on tion area
cont	acts	Termination	Socket	Pin					current 1	Contact to contact	Contact to housing							
		.ºº	й	<u>~</u>			_	mm	A	mm	mm	kVeff	kVrms	mm	AWG	mm²	Pin piece	Socket piece
		Solder	L	М	Р	N	0		15					1.4	18	1		
0	2				Р	Н	0	1.3	12	1	0.7	1.650	0.550	1.1	20	0.5	(\mathcal{Q})	(\mathcal{Q})
		Crimp ³	N	Р	Р	L	0		15					-	18-20	1.00-0.50		
		PCB ⁴	Q	R	Р	0	0		12					0.7	-	-		
		Solder	L	М	Р	N	0		15	0.8	0.6	1.000	0.333	1.4	18	1.00		
0	3				Р	Н	0	1.3	12	0.9	0.7	1.500	0.500	1.1	20	0.50		
		Crimp ³	N	Р	Р	L	0		15	8.0	0.6	1.000	0.333	-	18-20	1.00-0.50		
		PCB ⁴	Q	R	Р	0	0		12	0.9	0.7	1.500	0.500	0.7	-	-		
		Solder	L	М	J	G	0		7.5	1	1.1	1.500	0.500	0.85	22	0.38		
0		C-:3	N	Р	J	Н	0	0.9	10	0.7	8.0	1.000	0.333	-	20-24	0.50-0.25		
U	4	Crimp ³	IN	Г	J	G	0	0.9	7.5			4 500	0.500	-	22-26	0.38-0.15		
		PCB ⁴	Q	R	J	0	0		7.5	1	1.1	1.500	0.500	0.7	_	-		
					J	Н	0		10	0.6	0.6	1.000	0.333	1.1	20	0.50		
		Solder	L	М	J	G	0		7.5	0.9	0.9	1.350	0.450	0.85	22	0.38		
0	5				J	Н	0	0.9	10	0.6	0.6	1.000	0.333	-	20-24	0.50-0.25		
J	3	Crimp ³	N	Р	J	G	0							-	22-26	0.38-0.15		
		PCB ⁴	Q	R	J	0	0		7.5	0.9	0.9	1.350	0.450	0.7	-	-		
		I CD	ы	K		G	0		7.5	0.7	0.7	1.000	0.333	0.85	22	0.38		
		Solder	L	М	F													
					F	D	0		6	0.9	0.9	1.200	0.400	0.65	26	0.15		
0	6	Crimp ³	N	Р	F	G	0	0.7	7.5	0.7	0.7	1.000	0.333	-	22-26	0.38-0.15		
		PCB ⁴	Q	R	F	C 0	0		6	0.9	0.9	1.200	0.400	- 0.5	28-32	0.09-0.04		
								² SAE AS 3001.1 ³ Tools fo	13441:2 L. or crimpir sions for a	see page 1	od Istment	terminat ceptacle Max. ope level) ac method 3	uts, see paion only po and panel- rating volta c. to SAE AS 3001.1. nformation	essible in the mounted page at NN 5 13441:20	ne re- olug (sea)04			
		J.	Size	[1]				\int .										
1	2	3	4	5	6 7	, 8	9	10	11 12	13 14	- 15 11	6 17 1	18 19					
_	_	-		-			J											

SERIES K

PCB LAYOUTS

For PCB contacts (Size 1).





All specifications are only valid for socket inserts.

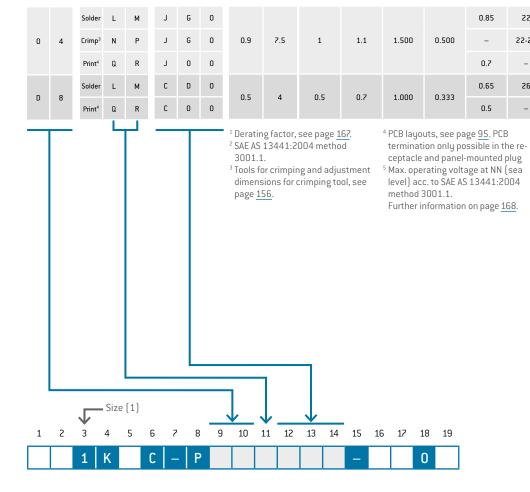
Pin inserts on request. Further PCB layouts upon request.

CONTACT INSERTS (SIZE 1)



c	nber		tact t	ype	Par	t num key	ber	Contact diameter	Single contact nominal		nd creepage ance	Test voltage ²	Nominal voltage ⁵	Termi- nation diameter		nation section		w on tion area
cont	tacts	Termination	Socket	Pin				mm	current ¹	Contact to contact mm	Contact to housing mm	kVeff	kVrms	mm	AWG	mm²	Pin piece	Socket piece
		Solder	L	м	F	G	0		7.5	0.7	0.7	1.000	0.333	0.85	22	0.38		
		Joidel	_	""	F	D	0		6	0.9	0.9	1.200	0.400	0.65	26	0.15		
0	7	Crimp ³	N	Р	F	G	0	0.7	7.5	0.7	0.7	1.000	0.333	-	22-26	0.38-0.15		
		Cillip	"		F	С	0		6	0.9	0.9	1.200	0.400	-	28-32	0.09-0.04		
		Print ⁴	Q	R	F	0	0		ь	0.9	0.9	1.200	0.400	0.5	-	-		
		Solder	L	м	F	G	0		7.5	0.4	0.6	0.900	0.300	0.85	22	0.38		
		Joidei	_	IVI	F	D	0		6	0.6	0.8	1.000	0.333	0.65	26	0.15	(A)	
0	8	Crimp ³	N	Р	F	G	0	0.7	7.5	0.4	0.6	0.900	0.300	-	22-26	0.38-0.15		
		Cillip		·	F	С	0		6	0.6	0.8	1.000	0.333	-	28-32	0.09-0.04		
		Print ⁴	Q	R	F	0	0		Ü	0.0	0.0	1.000	0.555	0.5	-	-		
		Solder	L	м	С	D	0		6	0.3	0.7	0.600	0.200	0.65	26	0.15		
1	0	Joidei	_		С	С	0	0.5	4	0.5	0.9	1.000	0.333	0.45	28	0.08	(683)	(693)
		Print ⁴	Q	R	С	0	0		7	0.5	0.5	1.000	0.555	0.5	-	-		
1	4	Solder	L	М	С	С	0	0.5	4	0.5	0.6	0.900	0.300	0.45	28	0.08	P	680
1	4	Print ⁴	Q	R	С	0	0	0.3	•	0.5	5.0	0.300	0.300	0.5	-	-		
1	6	Solder	L	М	С	С	0	0.5	4	0.4	0.6	0.900	0.300	0.45	28	0.08	688	688
1	J	Print ⁴	Q	R	С	0	0	5.5	-7	0.4	5.0	5.500	0.300	0.5	-	-		

SPECIFIC INSERTS FOR HIGH DATA TRANSMISSION RATES



⁶ ISO/IEC 11801:2017.

0.38-0.15

0.15

26

Further information on request. ⁷ Concerning data transmission protocols please note page 2.

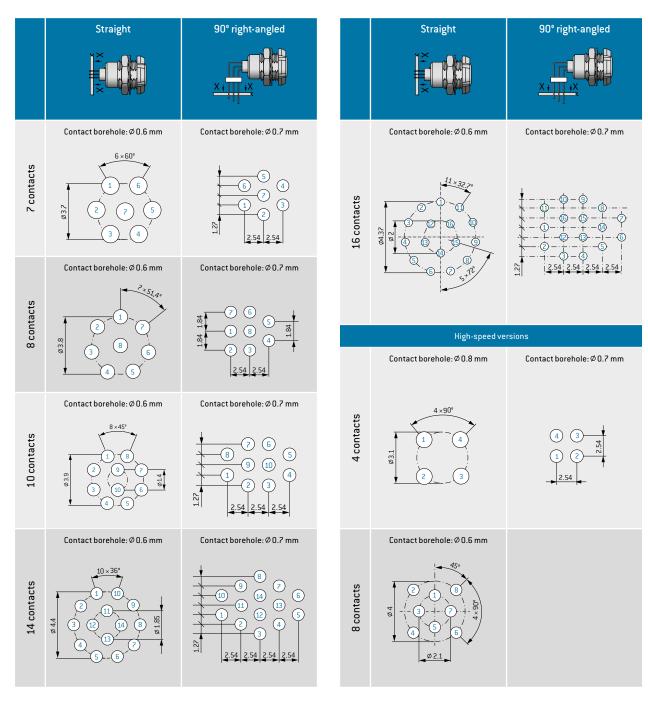
Ethernet^{6, 7} Type CAT 5⁷ up to 1 Gbit

SERIES K

PCB LAYOUTS

For PCB contacts (Size 1).





All specifications are only valid for socket inserts.

Pin inserts on request. Further PCB layouts upon request.

CONTACT INSERTS (SIZE 2)



Contacts
Solder L M T S 0 2 2 18 1.6 1 2.100 0.600 2.4 12 2.5 1.85 1.4 1.5 1.5 1.5 1.5 1.5 1.5 1.5 1.5 1.5 1.5
O 2 Crimp N P T N O O 2 18 1.6 1 2.100 0.700 - 14-18 1.50-1.00 O O O O O O O O O
Crimp ¹ N P T N 0 18 1.6 1 2.100 0.700 - 14-18 1.50-1.00 PCB ¹ Q R T 0 0 0
Solder L M S N 0 16 1.7 1.3 2.400 0.800 1.4 18 1.00 1.0 1.0 1.5 1.1 1.950 0.650 - 14-18 1.50-1.00 1.0
Crimp ³ N P S N 0 16 1.5 1.1 1.950 0.650 - 14-18 1.50-1.00 PGB ⁴ Q R S O O O 16 15 1.5 0.9 1.800 0.600 1.4 18 1.00 Crimp ³ N P P
Crimp ³ N P S L O 1.6 1.7 1.3 2.400 0.800 - 18-20 1.00-0.50 0.7
Comp ³ N P N O 15 1.1 0.8 1.500 0.500 1.4 18 1.00 0.500 0.7 0.500 0.500 0.7 0.500 0.500 0.7 0.500 0.500 0.7 0.500 0.7 0.500 0.7 0.500 0.7 0.500 0.7 0.500 0.7 0.500 0.7 0.500 0.7 0.500 0.7 0.500 0.7 0.7 0.500 0.7 0.7 0.500 0.7
PCB ⁴
O 4
0 4
Crimp ³ N P P H 0 12 1.8 1.2 1.950 0.650
P H 0 12 1.8 1.2 1.950 0.650 0.7 - 20-24 0.50-0.25 Color N P H 0 D D D D D D D D D
Solder L M P N 0 1.5 1.1 0.8 1.500 0.500 1.4 18 1.00 Crimp ³ N P P L 0 1.3 15 1.1 0.8 1.500 0.500 1.1 20 0.50 PCB ⁴ Q R P 0 0 0 12 1.5 1.1 0.8 1.500 0.500 - 18-20 1.00-0.50 PCB ⁴ Q R P 0 0 0 15 0.8 0.6 1.100 0.366 1.4 18 1.00 Solder L M P H 0 12 1.3 1.1 1.500 0.500 1.1 20 0.50 PCB ⁴ Q R P 0 0 0 1.3 15 0.8 0.6 1.100 0.366 - 18-20 1.00-0.50 PCB ⁴ Q R P 0 0 0 1.3 15 0.8 0.6 1.100 0.366 - 18-20 1.00-0.50 PCB ⁴ Q R P 0 0 0 1.3 15 0.8 0.6 1.100 0.366 - 18-20 1.00-0.50 PCB ⁴ Q R P 0 0 0 1.3 15 0.9 0.6 1.100 0.366 1.4 18 1.00 Solder L M P H 0 15 0.9 0.6 1.100 0.366 1.4 18 1.00 PCB ⁴ Q R P 0 0 0 1.3 15 0.9 0.6 1.100 0.366 - 18-20 1.00-0.50 PCF ⁶ Q R P 0 0 1.3 15 0.9 0.6 1.100 0.366 - 18-20 1.00-0.50 PCF ⁶ Q R P 0 0 1.3 15 0.9 0.6 1.100 0.366 - 18-20 1.00-0.50 PCF ⁶ Q R P 0 0 0 1.3 15 0.9 0.6 1.100 0.366 - 18-20 1.00-0.50 PCF ⁶ Q R P 0 0 0 1.3 15 0.9 0.6 1.100 0.366 - 18-20 1.00-0.50 PCF ⁶ Q R P 0 0 0 1.3 15 0.9 0.6 1.100 0.366 - 18-20 1.00-0.50 PCF ⁶ Q R P 0 0 0 1.3 15 0.9 0.6 1.100 0.366 - 18-20 1.00-0.50 PCF ⁶ Q R P 0 0 0 1.3 15 0.9 0.6 1.100 0.366 - 18-20 1.00-0.50 PCF ⁶ Q R P 0 0 0 1.3 15 0.9 0.6 1.100 0.366 - 18-20 1.00-0.50 PCF ⁶ Q R P 0 0 0 1.3 15 0.9 0.6 1.100 0.366 - 18-20 1.00-0.50 PCF ⁶ Q R P 0 0 0 1.3 15 0.9 0.6 1.100 0.366 - 18-20 1.00-0.50 PCF ⁶ Q R P 0 0 0 1.3 15 0.9 0.6 1.100 0.366 - 18-20 1.00-0.50 PCF ⁶ Q R P 0 0 0 1.3 15 0.9 0.6 1.100 0.366 - 18-20 1.00-0.50 PCF ⁶ Q R P 0 0 0 1.3 15 0.9 0.6 1.100 0.366 - 18-20 1.00-0.50 PCF ⁶ Q R P 0 0 0 1.3 15 0.9 0.6 1.100 0.366 - 18-20 1.00-0.50 PCF ⁶ Q R P 0 0 0 1.3 15 0.9 0.6 1.100 0.366 - 18-20 1.00-0.50 PCF ⁶ Q R P 0 0 0 1.3 15 0.9 0.6 1.100 0.366 - 18-20 1.00-0.50 PCF ⁶ Q R P 0 0 0 1.3 15 0.9 0.6 1.100 0.366 - 18-20 1.00-0.50 PCF ⁶ Q R P 0 0 0 1.3 15 0.9 0.6 1.100 0.366 - 18-20 1.00-0.50 PCF ⁶ Q R P 0 0 0 0 1.3 15 0.9 0.6 1.100 0.366 - 18-20 1.00-0.50 PCF ⁶ Q R P 0 0 0 0 1.3 15 0.9 0.6 1.100 0.366 PCF ⁶ Q R P 0 0 0 0 1.3 15 0.9 0.6 1.100 0.366 PCF ⁶ Q R P 0 0 0 0 0 0.
Solder L M P H 0 Crimp ³ N P P L 0 PCB ⁴ Q R P 0 0 Solder L M P H 0 Crimp ³ N P P L 0 1.3 15 1.1 0.8 1.500 0.500 - 18-20 1.00-0.50 PCB ⁴ Q R P 0 0 Solder L M P H 0 P H 0 12 1.6 1.3 1.800 0.600 0.500 - 20-24 0.50-0.25 Solder L M P H 0 12 1.6 1.3 1.800 0.600 0.7 Solder L M P H 0 12 1.3 1.1 1.500 0.500 1.1 20 0.50 PCB ⁴ Q R P 0 0 0 PCB ⁴ Q R P 0 0 0 Solder L M P H 0 12 1.3 1.1 1.500 0.500 0.7 Solder L M P H 0 12 1.3 1.1 1.500 0.500 0.7 Solder L M P H 0 12 1.3 1.1 1.500 0.500 0.7 Solder L M P H 0 12 1.3 1.1 1.500 0.500 0.7 Solder L M P H 0 12 1.3 1.1 1.800 0.600 1.1 20 0.50 PCB ⁴ Q R P 0 0 0 13 15 0.9 0.6 1.100 0.366 1.4 18 1.00 PCG ⁴ Q R P 0 0 14 1.3 1 1.800 0.600 1.1 20 0.50 PCB ⁴ Q R P 0 0 15 0.9 0.6 1.100 0.366 - 18-20 1.00-0.50 PCB ⁴ Q R P 0 0 17 1.3 1 1.800 0.600 - 20-24 0.50-0.25 PCB ⁴ Q R P 0 0 18 1.3 1 1.800 0.600 - 20-24 0.50-0.25 O,7 J H 0 10 10 1 0.66
O 5 Crimp ³ N P P L 0 1,3 15 1.1 0.8 1.500 0.500 - 18-20 1.00-0.50 P P H 0 12 1.6 1.3 1.800 0.600 0.7
Crimp ³ N P P H O 12 1.6 1.3 1.800 0.600
PCB ⁴ Q R P O O O 15 0.8 0.6 1.100 0.366 1.4 18 1.00 Crimp ³ N P P H O 12 1.3 1.1 1.500 0.500 1.1 20 0.50 PCB ⁴ Q R P O O 0 1.3 15 0.8 0.6 1.100 0.366 - 18-20 1.00-0.50 PCB ⁴ Q R P O O 0 1.3 15 0.9 0.6 1.100 0.366 1.4 18 1.00 Crimp ³ N P P H O 12 1.3 1.1 1.500 0.500 0.7 Solder L M P N O 12 1.3 1.1 1.500 0.500 0.7 PCB ⁴ Q R P O O 0 15 0.9 0.6 1.100 0.366 1.4 18 1.00 PCF Crimp ³ N P P H O 12 1.3 1 1.800 0.600 1.1 20 0.50 PCB ⁴ Q R P O O 1.3 15 0.9 0.6 1.100 0.366 - 18-20 1.00-0.50 PCB ⁴ Q R P O O 1.3 15 0.9 0.6 1.100 0.366 - 18-20 1.00-0.50 PCB ⁴ Q R P O O 1.3 15 0.9 0.6 1.100 0.366 - 18-20 1.00-0.50 PCB ⁴ Q R P O O 1.3 15 0.9 0.6 1.100 0.366 - 18-20 1.00-0.50 PCB ⁴ Q R P O O 1.3 15 0.9 0.6 1.100 0.366 - 18-20 1.00-0.50 PCB ⁴ Q R P O O 1.3 15 0.9 0.6 1.100 0.366 - 18-20 1.00-0.50 PCB ⁴ Q R P O O 1.3 15 0.9 0.6 1.100 0.366 - 18-20 1.00-0.50 PCB ⁴ Q R P O O 0 1.3 15 0.9 0.6 1.100 0.366 - 18-20 1.00-0.50 PCB ⁴ Q R P O O 0 1.3 15 0.9 0.6 1.100 0.366 - 18-20 1.00-0.50 PCB ⁴ Q R P O O 0 1.3 15 0.9 0.6 1.100 0.366 - 18-20 1.00-0.50 PCB ⁴ Q R P O O 0 1.3 15 0.9 0.6 1.100 0.366 - 18-20 1.00-0.50
O FCB4 Q R P O O O 15 0.8 0.6 1.100 0.366 1.4 18 1.00 Crimp3 N P P H O 1.3 15 0.8 0.6 1.100 0.366 - 18-20 1.00-0.50 PCB4 Q R P O O O 12 1.3 1.1 1.500 0.500 0.7 PCB4 Q R P O O O 1.3 15 0.9 0.6 1.100 0.366 1.4 18 1.00 Trimp3 N P P H O 1.3 15 0.9 0.6 1.100 0.366 1.4 18 1.00 Trimp3 N P P H O 1.3 15 0.9 0.6 1.100 0.366 1.4 18 1.00 Trimp3 N P P H O 1.3 15 0.9 0.6 1.100 0.366 - 18-20 1.00-0.50 Trimp3 N P P H O 1.3 15 0.9 0.6 1.100 0.366 - 18-20 1.00-0.50 Trimp3 N P P H O 1.3 15 0.9 0.6 1.100 0.366 - 18-20 1.00-0.50 Trimp3 N P P H O 1.3 15 0.9 0.6 1.100 0.366 - 18-20 1.00-0.50 Trimp3 N P O D 1.3 15 0.9 0.6 1.100 0.366 - 18-20 1.00-0.50 Trimp3 N P D D D D D D D D D D D D D D D D D D
Solder L M P H 0 12 1.3 1.1 1.500 0.500 1.1 20 0.50 Crimp ³ N P P L 0 1.3 15 0.8 0.6 1.100 0.366 - 18-20 1.00-0.50 PCB ⁴ Q R P 0 0 0 15 0.9 0.6 1.100 0.366 1.4 18 1.00 Solder L M P H 0 12 1.3 1 1.800 0.600 1.1 20 0.50 Crimp ³ N P P H 0 1.3 15 0.9 0.6 1.100 0.366 - 18-20 1.00-0.50 PCB ⁴ Q R P 0 0 1.3 15 0.9 0.6 1.100 0.366 - 18-20 1.00-0.50 PCB ⁴ Q R P 0 0 1.3 15 0.9 0.6 1.100 0.366 - 18-20 1.00-0.50 PCB ⁴ Q R P 0 0 0 1.3 15 0.9 0.6 1.100 0.366 - 18-20 1.00-0.50 PCB ⁴ Q R P 0 0 0 1.3 15 0.9 0.6 1.100 0.366 - 18-20 1.00-0.50 PCB ⁴ Q R P 0 0 0 1.3 15 0.9 0.6 1.100 0.366 - 18-20 1.00-0.50 PCB ⁴ Q R P 0 0 0 1.3 15 0.9 0.6 1.100 0.366 - 18-20 1.00-0.50 PCB ⁴ Q R P 0 0 0 1.3 15 0.9 0.6 1.100 0.366 - 18-20 1.00-0.50
P H O 12 1.3 1.1 1.500 0.500 1.1 20 0.50 Crimp ³ N P P L O 1.3 15 0.8 0.6 1.100 0.366 - 18-20 1.00-0.50 PCB ⁴ Q R P O O 0 12 1.3 1.1 1.500 0.500 0.7 Solder L M P H O 12 1.3 1 1.800 0.600 1.1 20 0.50 Crimp ³ N P P L O 1.3 15 0.9 0.6 1.100 0.366 1.4 18 1.00 Crimp ³ N P P L O 1.3 15 0.9 0.6 1.100 0.366 - 18-20 1.00-0.50 PCB ⁴ Q R P O O 1.3 15 0.9 0.6 1.100 0.366 - 18-20 1.00-0.50 PCB ⁴ Q R P O O 1.3 15 0.9 0.6 1.100 0.366 - 18-20 1.00-0.50 PCB ⁴ Q R P O O 1.3 15 0.9 0.6 1.100 0.366 - 18-20 1.00-0.50 PCB ⁴ Q R P O O 1.3 15 0.9 0.6 1.100 0.366 - 18-20 1.00-0.50 PCB ⁴ Q R P O O 1.3 15 0.9 0.6 1.100 0.366 - 18-20 1.00-0.50 PCB ⁴ Q R P O O 1.3 15 0.9 0.6 1.100 0.366 - 18-20 1.00-0.50
Crimp ³ N P P H O 12 1.3 1.1 1.500 0.500
P H O 12 1.3 1.1 1.500 0.500
PCB ⁴ Q R P 0 0 0 Solder L M P N 0 15 0.9 0.6 1.100 0.366 1.4 18 1.00 P H 0 12 1.3 1 1.800 0.600 1.1 20 0.50 Crimp ³ N P P L 0 1.3 15 0.9 0.6 1.100 0.366 - 18-20 1.00-0.50 PCB ⁴ Q R P 0 0 0 J H 0 10 1 0.6 1.1 20 0.50
O 7 Crimp ³ N P H O 12 1.3 1 1.800 0.600 1.1 20 0.50 PCB ⁴ Q R P O O 12 1.3 1 1.800 0.600 0.7 J H O 10 1 0.6 1.1 20 0.50
P H 0 12 1.3 1 1.800 0.600 1.1 20 0.50 Crimp ³ N P P H 0 1.3 15 0.9 0.6 1.100 0.366 - 18-20 1.00-0.50 PCB ⁴ Q R P 0 0 12 1.3 1 1.800 0.600 0.7 - 20-24 0.50-0.25 J H 0 10 1 0.6 1.1 20 0.50
Crimp ³ N P P H O 12 1.3 1 1.800 0.600 - 20-24 0.50-0.25 0.7 J H O 10 1 0.6 1.1 20 0.50
P H 0 PCB ⁴ Q R P 0 0 J H 0 10 1 0.6 - 20-24 0.50-0.25 J H 0 10 1 0.6 - 1.1 20 0.50
PCB ⁴ Q R P 0 0 0 0.7 J H 0 10 1 0.6 1.1 20 0.50
J G O 7.5 1.2 0.8 0.85 22 0.38
0 8 J H O 0.9 10 1 0.6 1.500 0.500 - 20-24 0.50-0.25
7.5 1.2 0.8
Solder L M
Crimp ³ N P
2.5 1 0.9 1.500 0.500
PCB ⁴ Q R J 0 0 0 0.7

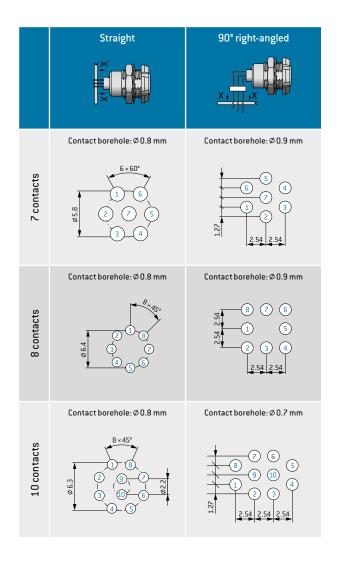
SERIES K

PCB LAYOUTS





	Straight	90° right-angled
2 contacts	Contact borehole: Ø 0.8 mm	Contact borehole: Ø 0.9 mm
3 contacts	Contact borehole: Ø 0.8 mm	Contact borehole: Ø 0.9 mm
4 contacts	Contact borehole: Ø 0.8 mm 4 × 90° 1 4 2 3	Contact borehole: Ø 0.9 mm
5 contacts	Contact borehole: Ø 0.8 mm	Contact borehole: Ø 0.9 mm 5 4 5 4 7 7 7 7 7 8 7 8 7 8 7 9 7 9 7 9
6 contacts	Contact borehole: Ø 0.8 mm	Contact borehole: Ø 0.9 mm



All specifications are only valid for socket inserts.

Pin inserts on request. Further PCB layouts upon request.

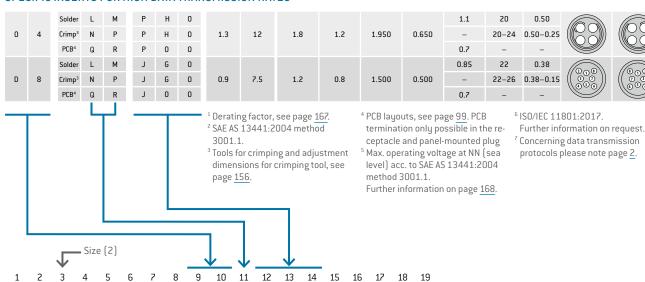
CONTACT INSERTS (SIZE 2)



Ethernet^{6, 7} Type CAT 6_A⁷ up to 10 Gbit

	nber of		tact t	ype I	Par	t num key	ber	Contact diameter	Single contact nominal		nd creepage ance	Test voltage ²	Nominal voltage ⁵	Termi- nation diameter		ination section		v on tion area
cont	tacts	Termination	Socket	Pin				mm	current ¹	Contact to contact mm	Contact to housing mm	kVeff	kVrms	mm	AWG	mm²	Pin piece	Socket piece
		Caldas			F	G	0		7.5	0.8	0.8	1.200	0.400	0.85	22	0.38		
		Solder	L	М	F	D	0		6	1	1	1.350	0.450	0.6	26	0.15	00	000
1	2	C : 3	M	В	F	G	0	0.7	7.5	0.8	0.8	1.200	0.400	-	22-26	0.38-0.15		
		Crimp ³	N	Р	F	С	0		6			4.250	0.450	-	28-32	0.09-0.04		
		PCB ⁴	Q	R	F	0	0		6	1	1	1.350	0.450	0.5	-	-		
					F	G	0		7.5	0.7	0.7	1.100	0.366	0.85	22	0.38		
		Solder	L	М	F	D	0		6	0.9	0.9	1.200	0.400	0.6	26	0.15	600	600
1	4			_	F	G	0	0.7	7.5	0.7	0.7	1.100	0.366	-	22-26	0.38-0.15		
		Crimp ³	N	Р	F	С	0					4.000	0.400	-	28-32	0.09-0.04		
		PCB ⁴	Q	R	F	0	0		6	0.9	0.9	1.200	0.400	0.5	-	-		
					F	G	0		7.5	0.6	0.7	0.900	0.300	0.85	22	0.38		
		Solder	L	М	F	D	0		6	0.8	0.9	1.100	0.366	0.6	26	0.15	(OO)	(QQ)
1	6	0 : 3		_	F	G	0	0.7	7.5	0.6	0.7	0.900	0.300	-	22-26	0.38-0.15		
		Crimp ³	N	Р	F	С	0						0.000	-	28-32	0.09-0.04		
		PCB ⁴	Q	R	F	0	0		6	0.8	0.9	1.100	0.366	0.5	-	-		
					F	G	0		7.5	0.5	0.7			0.85	22	0.38		
		Solder	L	М	F	D	0		6	0.7	0.9			0.6	26	0.15	ADD	6000
1	8	0 : 3		D	F	G	0	0.7	8	0.5	0.7	0.900	0.300	-	22-26	0.38-0.15		(86,33)
		Crimp ³	N	Р	F	С	0		6	0.7	0.0			-	28-32	0.09-0.04		
		PCB ⁴	Q	R	F	0	0		6	0.7	0.9			0.5	-	-		
		Solder			F	G	0		7.5	0.5	0.7	0.900	0.300	0.85	22	0.38		
		Solder	L	М	F	D	0		6	0.7	0.9	1.000	0.333	0.6	26	0.15	6920	692
1	9	C : 3	N	Р	F	G	0	0.7	7.5	0.5	0.7	0.900	0.300	-	22-26	0.38-0.15	(8833)	(8888)
		Crimp ³	N	Р	F	С	0		C	0.7	0.0	4.000	0.222	-	28-32	0.09-0.04		
		PCB ⁴	Q	R	F	0	0		6	0.7	0.9	1.000	0.333	0.5	-	-		
2	6	Solder	L	М	С	С	0	0.5	4	0.6	0.8	0.900	0.300	0.4	28	0.08		
_		PCB ⁴	Q	R	С	0	0						-5.5.5.0	0.5	-	-		

SPECIFIC INSERTS FOR HIGH DATA TRANSMISSION RATES



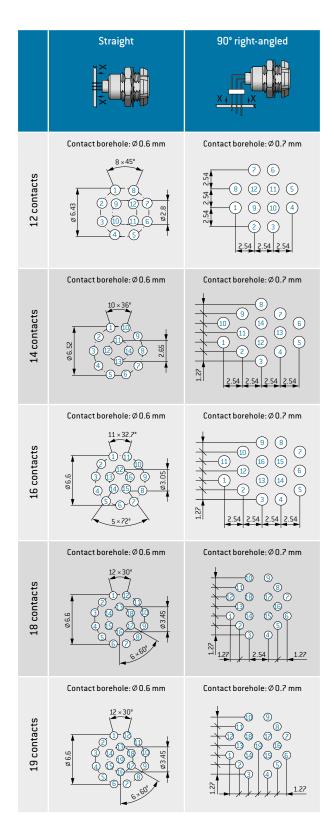
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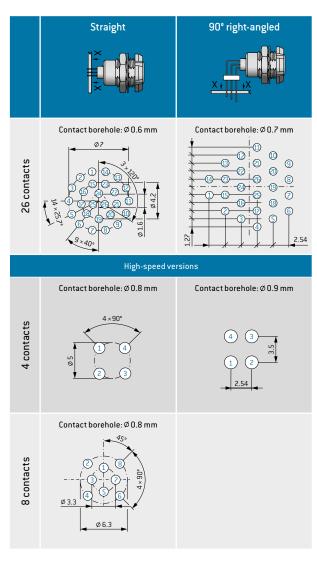
SERIES K

PCB LAYOUTS









All specifications are only valid for socket inserts.

Pin inserts on request. Further PCB layouts upon request.

CONTACT INSERTS (SIZE 3)



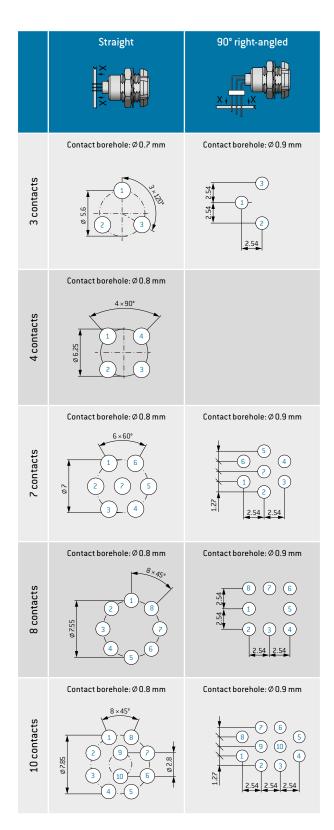
	nber	Con	tact t	ype	Pai	rt num key	ber	Contact diameter	Single contact		and creepage	Test voltage ²	Nominal voltage ⁵	Termi- nation		ination -section		w on tion area
	tacts	Termination	Socket	Pin		Key		mm	nominal current ¹	Contact to contact mm	Contact to housing mm		kVrms	diameter mm	AWG	mm²	Pin piece	Socket piece
		_	0,	_	Т	S	0		24	1.8	1.2	Kreii	KVIIIS	2.4	12	2.5	7 m piece	SOCIACY PICCO
0	3	Solder	L	М	T	0	0	2	24	1.0	1.2	1.800	0.600	1.85	14	1.5		
ŭ	ŭ	PCB ⁴	Q	R	T	0	0	_	18	2	1.4	1.000	0.000	0.7	-	_		
					Т	S	0		24	1.4	0.9			2.4	12	2.5		
0	4	Solder	L	М	Т	Q	0	2				1.650	0.550	1.85	14	1.5		
		PCB ⁴	Q	R	T	0	0		18	1.6	1.1			0.7	-	-		
		Solder	L	М	S	N	0		16	1.5	1.3			1.4	18	1.00		
0	7	Crimp ³	N	Р	S	N	0	1.6	21	1.1	0.9	1.800	0.600	-	14-18	1.50-1.00		
U	,	СППР	IN	'	S	L	0	1.0	16	1.5	1.3	1.000	0.000	-	18-20	1.00-0.50		
		PCB ⁴	Q	R	S	0	0		10	1.3	1.1			0.7	-	-		
		Solder	L	М	Р	N	0		15	1.1	0.9	1.350	0.450	1.4	18	1.00	_	
			_		Р	Н	0		12	1.4	1.2	1.650	0.550	1.1	20	0.50	600	600
0	8	Crimp ³	N	Р	Р	L	0	1.3	15	1.1	0.9	1.350	0.450	-	18-20	1.00-0.50		
					Р	Н	0		12	1.4	1.2	1.650	0.550	-	20-24	0.50-0.25		
		PCB ⁴	Q	R	Р	0	0			1.2	1			0.7	-	-		
		Solder	L	М	Р	N	0		15	0.9	0.3	1.100	0.366	1.4	18	1.00	600	
1	0	2024		_	Р	Н	0	1.3	12	1.2	0.6	1.350	0.450	1.1	20	0.50		
		PCB ⁴	Q	R	P	0 H	0		10	0.8	0.2	1.000	0.333	0.7	- 20	0.50		
		Solder	L	М	J	G	0		7.5	1.1	1	1.350	0.353	0.85	22	0.30		
1	4				J	Н	0	0.9	10	0.8	0.7	1.000	0.430	-	20-24	0.50-0.25		
1	4	Crimp ³	N	Р	J	G	0	0.5	10	0.6	U.r	1.000	0.555	_	22-26	0.38-0.15		
		PCB ⁴	Q	R	J	0	0		7.5	1.1	1	1.350	0.450	0.7	_	-		
		100	L	٦		-	Ü	¹ Deratin	g factor,	see page 1	167.	³ Tools for	crimping a			Max. opera	ating voltage	at NN (sea
								'SAE AS 3001.1		004 metho	od	page 156 ⁴ PCB layo terminat		age <u>101</u> . Possible in t	CB :he re-	method 30	to SAE AS 13 DD 1.1. Formation on	
			Size	(3)														
	_	V			•		_	<u>\\</u> '	<u> </u>	40								
1	2	3	4	5	6 7	' '	3 9	10	11 12	13 14	15 1	6 17 1	เช 19					
1	1	2	17		<u></u>													

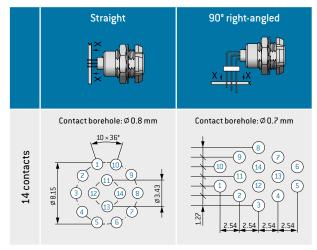
SERIES K

PCB LAYOUTS

For PCB contacts (Size 3).







All specifications are only valid for socket inserts.

Pin inserts on request. Further PCB layouts upon request.

CONTACT INSERTS (SIZE 3)

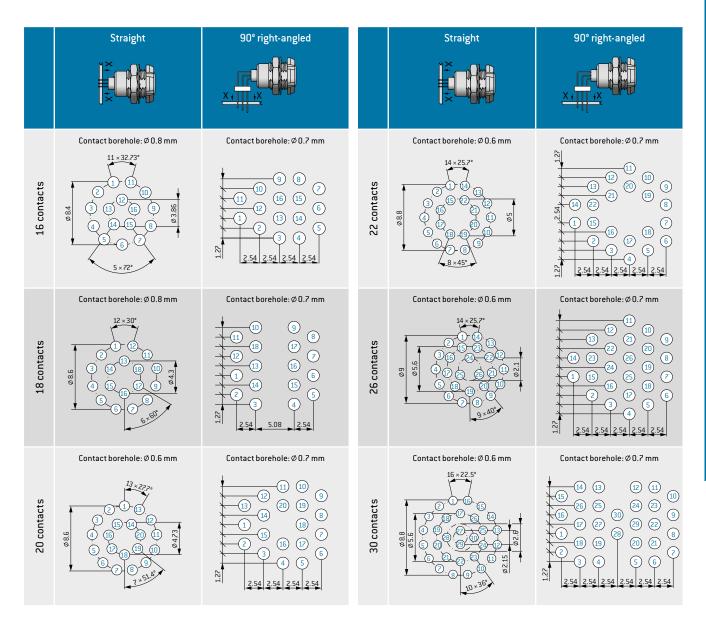


	nber of	Con	tact t	ype	Par	rt num key	ber	Contact diameter	Single contact		ind creepage ance	Test voltage ²	Nominal voltage ⁵	Termi- nation		ination -section		w on tion area
	acts	Termination	Socket	Pin		Key		mm	nominal current ¹	Contact to contact mm	Contact to housing mm	kVeff	kVrms	diameter mm	AWG	mm²	Pin piece	Socket piece
					J	Н	0		10	0.7	0.6	1.000	0.333	1.1	20	0.50	r iii piooo	oodiist piood
		Solder	L	М	J	G	0		7.5	1	0.9	1.350	0.450	0.85	22	0.38	(OO)	(OO)
1	6				J	Н	0	0.9	10	0.7	0.6	1.000	0.333	_	20-24	0.50-0.25		
		Crimp ³	N	Р	J	G	0							-	22-26	0.38-0.15		
		PCB ⁴	Q	R	J	0	0		7.5	1	0.9	1.350	0.450	0.7	-	-		
		Caldan			J	Н	0		10	0.7	0.6	1.000	0.333	1.1	20	0.50		
		Solder	L	М	J	G	0		7.5	0.9	0.8	1.350	0.450	0.85	22	0.38	699	699
1	8	Crimp ³	N	Р	J	Н	0	0.9	10	0.7	0.6	1.000	0.333	-	20-24	0.50-0.25		
		Cillip	IN	r	J	G	0		7.5	0.9	0.8	1.350	0.450	-	22-26	0.38-0.15		
		PCB ⁴	Q	R	J	0	0		1.5	0.5	0.0	1.550	0.430	0.7	-	-		
		Solder	L	М	F	G	0		7.5	0.8	0.9	1.000	0.333	0.85	22	0.38		
			_		F	D	0		6	1	1.1	1.100	0.366	0.6	26	0.15		(PSP)
2	0	Crimp ³	N	Р	F	G	0	0.7	7.5	0.8	0.9	1.000	0.333	-	22–26	0.38-0.15		
					F	С	0		6	1	1.1	1.100	0.366	-	28-32	0.09-0.04		
		PCB ⁴	Q	R	F	0	0							0.5	-	-		
		Solder	L	М	F	G	0		7.5	0.7	1.7	1.000	0.333	0.85	22	0.38		
					F	D	0		6	0.9	1.9	1.100	0.366	0.6	26	0.15		
2	2	Crimp ³	N	Р	F	G	0	0.7	7.5	0.7	1.7	1.000	0.333	-	22–26	0.38-0.15		
					F	С	0		6	0.9	1.9	1.100	0.366	-	28-32	0.09-0.04		
		PCB ⁴	Q	R	F	0	0							0.5	-	-		
		Solder	L	М	F	G	0		7.5	0.5	0.6	0.900	0.300	0.85	22	0.38		
	_				F	D	0		6	0.7	0.8	1.000	0.333	0.6	26	0.15		
2	6	Crimp ³	N	Р	F	G	0	0.7	7.5	0.5	0.6	0.900	0.300	-	22-26	0.38-0.15		
		DOD4	0	_	F	С	0		6	0.7	0.8	1.000	0.333	-	28-32	0.09-0.04		
		PCB ⁴	Q	R	F	0	0		7.5	0.8	0.9			0.5	-	-		
		Solder	L	М	F	G D	0		7.5 6	0.4	0.7			0.85	22 26	0.38		
3	0				F	G	0	0.7	7.5	0.6	0.9	0.900	0.300	-	22–26	0.15		
3	Ü	Crimp ³	N	Р	F.	С	0	0.1	1.5	0.6	0.9	0.300	0.300	_	28-32	0.09-0.04		
		PCB ⁴	Q	R	F	0	0		6	0.7	1			0.5		-		
		P.C.B.	u L	R		T	U		13441:2	see page 1	167.		crimping a	nd adjustr	see		ating voltage to SAE AS 13	
									1			terminat	uts, see pa ion only pc and panel	ssible in t	he re-	Further in I	formation on	page <u>168</u> .
		$\overline{}$	Size	(3)				↓ .		\downarrow								
1	2	3	4	5	6 7	, 8	9	10	11 12	13 14	- 15 16	5 17 1	l8 19					
		3	K		c -	- F							0					

PCB LAYOUTS



For PCB contacts (Size 3).



All specifications are only valid for socket inserts.

Pin inserts on request. Further PCB layouts upon request.

CONTACT INSERTS (SIZE 4)



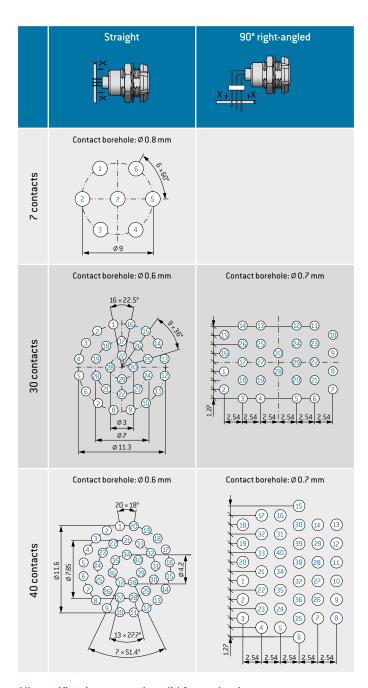
	nber of		itact t	ype	Pa	rt num key	ber	Contact diameter	Single contact nominal	Clearance a	and creepage ance		Nominal voltage 5	Termi- nation diameter		nation section		w on tion area
con	tacts	Termination	Socket	Pin				mm	current ¹	Contact to contact mm	Contact to housing mm	kVeff	kVrms	mm	AWG	mm²	Pin piece	Socket piece
	77	Solder	L	М	T	S	9	2	24	1.5	1	1.350	0.450	2.40	12	2.50		
0	75	PCB ³	Q	R	T	0	9	2	18	2.1	1.6	1.650	0.550	1.85 0.7	14	1.5		
		Solder	L	М	J	G	0							0.85	22	0.38		
3	0	PCB ³	Q	R	J	0	0	0.9	7.5	0.8	1	1.575	0.520	0.5	-	-		
		Solder	L	М	F	G	0		7.5	0.6	0.8	0.900	0.300	0.85	22	0.38		
4	0	PCB ³	Q	R	F	D 0	0	0.7	6	0.8	1	1.000	0.333	0.6 0.5	26 -	0.15		
1	2	3	Size	(4)	6	7 8	3 9	² SAE AS 3001.1 ³ PCB lau	13441:2 	see page 1004 method page 105	od Si	level) methor Further 5 Not co	perating vol- acc. to SAE A d 3001.1. er informatio mpatible to	S 13441:20	.68.			
1	۷			5	_	- F		10	11 12	13 14	15	10 17						
		4	K L		C -	-							0					

SERIES K

PCB LAYOUTS







All specifications are only valid for socket inserts.

Pin inserts on request. Further PCB layouts upon request.

RIGHT-ANGLED PCB CONTACTS IN THE RECEPTACLE



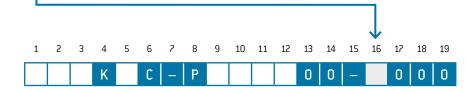
A



TECHNICAL DATA

- Pin version on request.
- PCB layouts, see page <u>91</u>.

Contact diameter	Termination diameter
0.5	0.5
0.7	0.6
0.9	0.6
1.3	0.8
1.6	0.8
2	0.8



FOR YOUR NOTES

CABLE COLLET SYSTEM

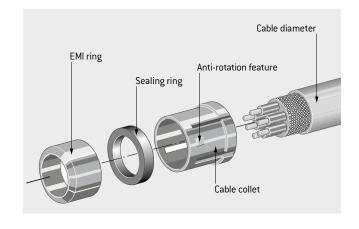


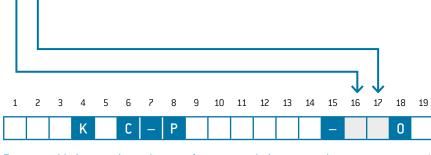
1	5
2	0
2	5
3	0
3	5
4	0
4	5
5	0
5	5
6	0
6	5
7	0
7	5
8	0
8	5
9	0
9	5
0	1
0	2
0	3
1	4
0	0

Cable diameter			Size		
mm	0	1	2	3	4
> 1 – 1.5		•			
> 1.5 – 2	•	•			
> 2 – 2.5	•	•			
> 2.5 – 3	•	•	•		
> 3 – 3.5	•	•	•	•	
> 3.5 – 4	•	•	•	•	
> 4 – 4.5	•	•	•	•	
> 4.5 – 5	•	•	•	•	
> 5 – 5.5		•	•	•	
> 5.5 – 6		•	•	•	
> 6 - 6.5		•	•	•	
> 6.5 – 7		•	•	•	
> 7 – 7.5			•	•	•
> 7.5 – 8			•	•	
> 8 - 8.5			•	•	•
> 8.5 – 9			•	•	
> 9 – 9.5				•	•
> 9.5 – 10				•	
> 10 - 10.5				•	•
> 10.5 – 11.5					•
> 13.5 – 14					•
Without cable coll	et sy	stem	(on r	eque	st)

APPLICATION: For all plugs and in-line receptacles and for receptacle style 6 and 7.

USE: Cable collet for strain relief; sealing ring for cable seal; EMI ring for transmission of the shielding.



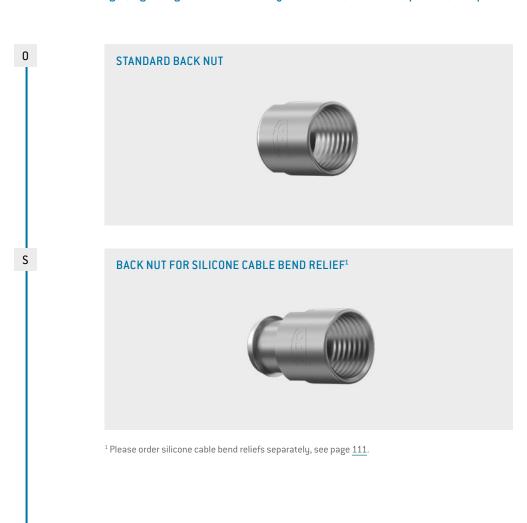


 $For assembly instructions \ please \ refer to \ our \ website: \\ \underline{www.odu-connectors.com/downloads/assembly-instructions}$

DEFINITION OF THE BACK NUTS



Usable for all straight, right-angled and Break-Away connectors, in-line receptacles, receptacles style 6.



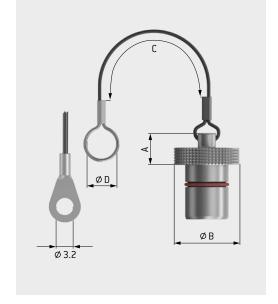
1 2 3 4 5 6 7 8 9 10 11 12 13 14 15 16 17 18 19

PROTECTIVE COVERS



FOR RECEPTACLE TYPES

Size	Part number	A	Ø B	С	ØD
		mm	mm	mm	mm
0	720.097.007.21500	8	15	70	6
1	721.097.007.21500	9	18.5	75	8
2	722.097.007.21500	9	21.5	85	10
3	723.097.007.21500	9.6	24	120	12
4	724.097.007.21500	11.2	31.5	140	16

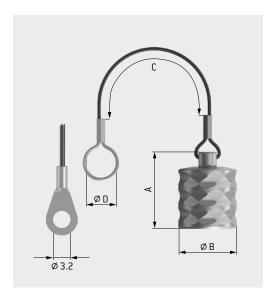


	Lanyard material							
0	Polyamide lanyard with loop							
1	Stainless steel lanyard with loop							
2	Polyamide lanyard with solder lug							
3	Stainless steel lanyard with solder lug							

Surface matt chromate

FOR PLUG (IP 68)

Size	Part number	A	Ø B	С	ØD
		mm	mm	mm	mm
0	720.097.004.2150_	16	14	70	6
1	721.097.004.2150_	21	16	75	8
2	722.097.004.2150_	21.5	20	85	10
3	723.097.004.2150_	25.5	24	130	12
4	724.097.004.2150_	28	30	140	16



Lanyard material							
0	Polyamide lanyard with loop						
1	Stainless steel lanyard with loop						
2	Polyamide lanyard with solder lug						
3	Stainless steel lanyard with solder lug						

Surface matt chromate

Size	Keyings (see page 88)									
	0	Α	С	F	Н	K	Q	W		
0	•	•	•	•	0	0	0	0		
1	•	•	•	•	0	0	0	0		
2	•	•	•	•	0	0	0	0		
3	•	•	0	0	0	0	0	0		
4	•	0	0	0	0	0	0	0		

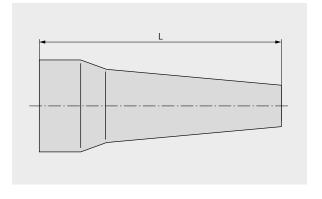
[•] Standard, • On request.

SERIES K

SILICONE CABLE BEND RELIEFS



Size	Part number	Dim. L	Cable jacket (Ø outside)		
		mm	min.	max.	
	700.023965.020		2	2.5	
	700.023965.025		2.5	3	
0	700.023965.030	27	3	3.5	
0	700.023965.035	27	3.5	4	
	700.023965.040		4	4.5	
	700.023965.045		4.5	5	
	701.023965.025		2.5	3	
	701.023965.030		3	3.5	
	701.023965.035		3.5	4	
1	701.023965.040	30	4	5	
	701.023965.050		5	6	
	701.023965.060		6	6.5	
	701.023965.070		6.5	7.5	
	702.023965.025		2.5	3	
	702.023965.030		3	3.5	
	702.023965.035		3.5	4	
2	702.023965.040	36	4	5	
	702.023965.050	30	5	6	
	702.023965.060		6	7	
	702.023965.070		7	8	
	702.023965.080		8	9	
	703.023965.040		4	5	
	703.023965.050		5	6	
	703.023965.060		6	7	
3	703.023965.070	42	7	8	
3	703.023965.080	46	8	9	
	703.023965.090		9	10	
	703.023965.100		10	11	
	703.023965.110		11	12	
	704.023965.080		8	10	
4	704.023965.100	60	10	12	
7	704.023965.120	00	12	14	
	704.023965.140		14	16	



TEMPERATURE RANGE

Silicone: $-50\,^{\circ}\text{C}$ up to $+200\,^{\circ}\text{C}$, short-term up to $+230\,^{\circ}\text{C}$ Autoclaveable

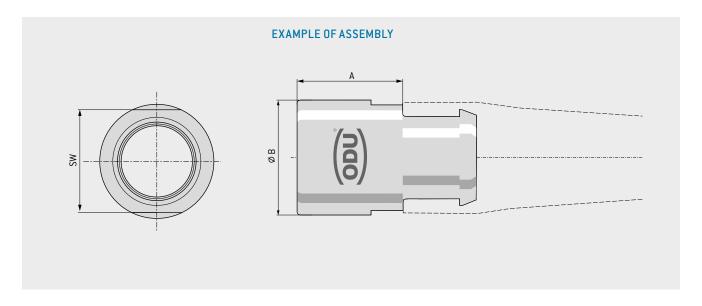
COLORS

Color code	Color	RAL no. ¹ (similar)
202	Red	3020
203	White	9010
204	Yellow	1016
205	Green	6029
206	Blue	5002
207	Gray	7005
208	Black	9005

 $^{^{\}rm 1}{\rm Because}$ of different raw materials, the colors may slightly differ from RAL number

BACK NUT FOR CABLE BEND RELIEFS





Size	Part number	Α	ØB	SW
		mm	mm	mm
0	700.022.117.3002	8	8.9	7
1	701.022.117.3002	10	10.9	10
2	702.022.117.3002	11.5	13.9	13
3	753.022.117.3002	11.5	16.9	15
4	704.022.117.3002	15	23	20

Surface							
15	Cu-alloy/matt chrome plated						
11	Cu-alloy/black chrome plated						
04	Cu-alloy/nickel						

FOR YOUR NOTES



ODU MINI-SNAP®



The following pages contain tools and wrenches to ensure that your ODU connectors function flawlessly.

CRIMPING TOOLS / ASSEMBLY TOOLS





PART NUMBER CRIMPING TOOL 080.000.051.000.000

Part number positioner, see table.

PROCESSING TOOL FOR CRIMP CONTACTS

Digital adjustment, multiposition

Size	Number of con- tacts	Contact diameter		nination s-section	Adjust- ment dim.	Positioner	Positioning setting		Removal tool
		mm	AWG	mm²	mm		Pin	Socket	
	4-5	0.7	28-32	0.09-0.04	0.57	080.000.051.105.000	1	2	087.7CC.070.001.000
0	4-5	0.7	22-26	0.38-0.15	0.67	080.000.051.105.000	1	2	087.7CC.070.001.000
U	2–3	0.9	22-26	0.38-0.15	0.67	080.000.051.105.000	3	4	087.7CC.090.001.000
	2–3	0.9	20-24	0.5-0.25	0.67	080.000.051.105.000	3	4	087.7CC.090.001.000
	6-8	0.7	28-32	0.09-0.04	0.57	080.000.051.105.000	1	5	087.7CC.070.001.000
	6-8	0.7	22-26	0.38-0.15	0.67	080.000.051.105.000	1	5	087.7CC.070.001.000
1	4-5	0.9	22-26	0.38-0.15	0.67	080.000.051.105.000	3	6	087.7CC.090.001.000
	4-5	0.9	20-24	0.5-0.25	0.67	080.000.051.105.000	3	6	087.7CC.090.001.000
	2–3	1.3	18-20	1-0.5	1.12	080.000.051.105.000	7	8	087.7CC.130.001.000
	12-19	0.7	28-32	0.09-0.04	0.57	080.000.051.106.000	1	2	087.7CC.070.001.000
	12-19	0.7	22-26	0.38-0.15	0.67	080.000.051.106.000	1	2	087.7CC.070.001.000
	8-10	0.9	22-26	0.38-0.15	0.67	080.000.051.106.000	3	4	087.7CC.090.001.000
	8-10	0.9	20-24	0.5-0.25	0.67	080.000.051.106.000	3	4	087.7CC.090.001.000
	4-7	1.3	20-24	0.5-0.25	0.67	080.000.051.106.000	5	6	087.7CC.130.001.000
2	4-7	1.3	18-20	1-0.5	1.12	080.000.051.106.000	5	6	087.7CC.130.001.000
	3	1.6	18-20	1-0.5	1.12	080.000.051.107.000	1	2	087.7CC.160.001.000
	3	1.6	18	1.5–1	1.12	080.000.051.107.000	1	2	087.7CC.160.001.000
	3	1.6	14-16	1.5–1	1.3	080.000.051.107.000	1	2	087.7CC.160.001.000
	2	2	18	1.5–1	1.12	080.000.051.107.000	3	4	087.7CC.200.002.000
	2	2	14-16	1.5–1	1.3	080.000.051.107.000	3	4	087.7CC.200.002.000
	20-30	0.7	28-32	0.09-0.04	0.57	080.000.051.106.000	1	7	087.7CC.070.001.000
	20-30	0.7	22-26	0.38-0.15	0.67	080.000.051.106.000	1	7	087.7CC.070.001.000
	14-18	0.9	22–26	0.38-0.15	0.67	080.000.051.106.000	3	8	087.7CC.090.001.000
	14-18	0.9	20-24	0.5-0.25	0.67	080.000.051.106.000	3	8	087.7CC.090.001.000
3	8-10	1.3	20-24	0.5-0.25	0.67	080.000.051.106.000	5	9	087.7CC.130.001.000
	8-10	1.3	18-20	1-0.5	1.12	080.000.051.106.000	5	9	087.7CC.130.001.000
	7	1.6	18-20	1-0.5	1.12	080.000.051.107.000	1	5	087.7CC.160.001.000
	7	1.6	18	1.5–1	1.12	080.000.051.107.000	1	5	087.7CC.160.001.000
	7	1.6	14-16	1.5-1	1.3	080.000.051.107.000	1	5	087.7CC.160.001.000

CRIMPING TOOLS / ASSEMBLY TOOLS





PART NUMBER CRIMPING TOOL 080.000.037.000.000

Part number positioner, see table.

PROCESSING TOOL FOR CRIMP CONTACTS

Mil approved, single position

Size	Number of con- tacts	Contact diameter	_	nination s-section	Posit	ioner I	Selector setting		Removal tool
		mm	AWG	mm²	Pin	Socket	Pin	Socket	
	4–5	0.7	28-32	0.09-0.04	081.701.002.848.037		3		087.7CC.070.001.000
0	4–5	0.7	22–26	0.38-0.15	081.701.002.848.037		4		087.7CC.070.001.000
0	2–3	0.9	22–26	0.38-0.15	081.701.002.849.037	081.700.004.749.037	4	4	087.7CC.090.001.000
	2–3	0.9	20-24	0.5-0.25	081.701.003.849.037	081.700.003.749.037	7/6/51	7/6/51	087.7CC.090.001.000
	6-8	0.7	28-32	0.09-0.04	081.701.002.848.037	081.701.002.748.037	3	3	087.7CC.070.001.000
1	6-8	0.7	22–26	0.38-0.15	081.701.002.848.037	081.701.002.748.037	4	4	087.7CC.070.001.000
1	4–5	0.9	22–26	0.38-0.15	081.701.002.849.037	081.701.002.749.037	4	4	087.7CC.090.001.000
	4-5	0.9	20-24	0.5-0.25	081.701.003.849.037	081.701.003.749.037	7/6/51	7/6/51	087.7CC.090.001.000
	12–19	0.7	28-32	0.09-0.04	081.702.001.848.037	081.702.001.748.037	3	3	087.7CC.070.001.000
2	12–19	0.7	22–26	0.38-0.15	081.702.001.848.037	081.702.001.748.037	4	4	087.7CC.070.001.000
2	8-10	0.9	22–26	0.38-0.15	081.701.002.849.037	081.702.003.749.037	4	4	087.7CC.090.001.000
	8-10	0.9	20-24	0.5-0.25	081.701.003.849.037	081.702.002.749.037	7/6/51	7/6/51	087.7CC.090.001.000
	20-30	0.7	28-32	0.09-0.04	081.702.001.848.037	081.703.002.748.037	3	3	087.7CC.070.001.000
	20-30	0.7	22–26	0.38-0.15	081.702.001.848.037	081.703.002.748.037	4	4	087.7CC.070.001.000
3	14-18	0.9	22–26	0.38-0.15	081.701.002.849.037		4		087.7CC.090.001.000
3	14-18	0.9	20-24	0.5-0.25	081.701.003.849.037		7/6/51		087.7CC.090.001.000
	8	1.3	20-24	0.5-0.25	081.703.001.844.037	081.703.001.744.037	7/6/51	7/6/51	087.7CC.130.001.000
	8	1.3	18-20	1-0.5		081.703.001.744.037		5	087.7CC.130.001.000

 $^{^{1}\,\}mbox{For AWG}$ 20 position 7 / for AWG 22 position 6 / for AWG 24 position 5.

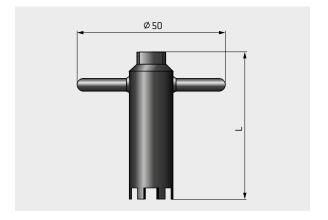
SPANNER WRENCH

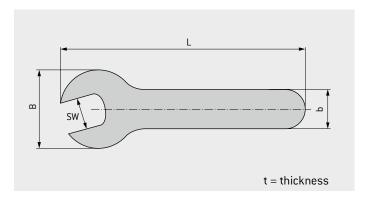
NUTDRIVER FOR SLOTTED MOUNTING NUT



Part number	Dimensions in mm				
	SW	t	В	L	b
598.700.001.016.000	5	1.5	16	92	8
598.700.001.015.000	5.5	1.5	16	92	8
598.700.001.021.000	6	2	16	92	8
598.700.001.011.000	7	2	16	92	8
598.700.001.001.000	8	2	16	92	8
598.700.001.022.000	9	2	21.5	102	9
598.700.001.002.000	10	2	21.5	102	9
598.700.001.012.000	11	2	24.5	115	10
598.700.001.003.000	12	2.5	24.5	115	10
598.700.001.017.000	12.5	4	24.5	115	10
598.700.001.004.000	13	2.5	30.5	98	16.5
598.700.001.005.000	14	2.5	30.5	98	16.5
598.700.001.006.000	15	3	35.5	145	15
598.700.001.007.000	16	3	35.5	145	15
598.700.001.008.000	17	3	35.5	145	15
598.700.001.023.000	18	3	42	172	16
598.700.001.013.000	19	3	42	172	16
598.700.001.009.000	20	3	42	172	16
598.700.001.018.000	21	3	42	172	16
598.700.001.010.000	22	3	47	119	23.5
598.700.001.014.000	24	3	54	119	23.5
598.700.001.024.000	27	3	55	150	25
598.700.001.019.000	30	3	50	150	25
598.700.001.020.000	31	3	50	150	25

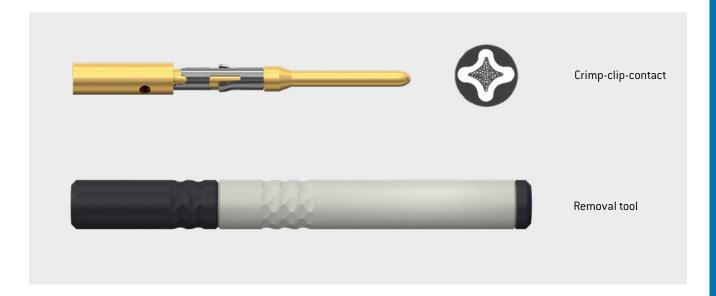
Nutdriver	Thread	Length in mm				
		L				
SUITABLE FOR STYLE 8 / S	SUITABLE FOR STYLE 8 / SERIES L AND B:					
700.098.002.000.000	M 9 × 0.5	50				
700.098.001.000.000	$M~10\times0.5$	50				
700.098.001.000.000	M 12 × 1	50				
701.098.002.000.000	M 14 × 1	60				
701.098.001.000.000	M 15 × 1	60				
702.098.001.000.000	M 16 × 1	60				
702.098.001.000.000	M 18 × 1	60				
703.098.001.000.000	M 20 × 1	60				
SUITABLE FOR STYLE 3 / S	ERIES K:					
701.098.002.000.000	M 14 × 1	60				
721.098.001.000.000	M 16 × 1	60				
703.098.001.000.000	M 20 × 1	60				
724.098.001.000.000	M 30 × 1	60				





REMOVAL TOOLS FOR CRIMP-CLIP-CONTACTS





Part number	Contact Ø	
	mm	
087.7CC.070.001.000	0.7	
087.7CC.090.001.000	0.9	
087.7CC.130.001.000	1.3	
087.7CC.160.001.000	1.6	
087.7CC.200.002.000	2	

ASSEMBLY TOOL FOR CONNECTOR SERIES K



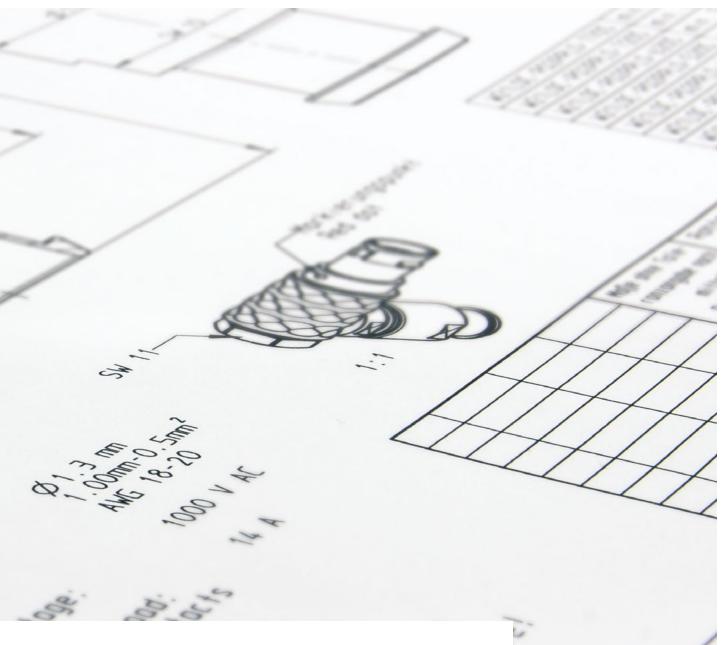
PART NUMBER 080.000.055.000.000

- Suitable from size 0 to 4.
- To clamp the inner housing for back nut assembly.
- Incl. jaws for bench vise fixi g for easy handling.

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ODU MINI-SNAP®



TECHNICAL INFORMATION

ODU connectors ensure perfect and reliable transmission of power, signal, data and other media in a wide variety of applications.

Further information can be found on the following pages.

INTERNATIONAL PROTECTION CLASSES

i

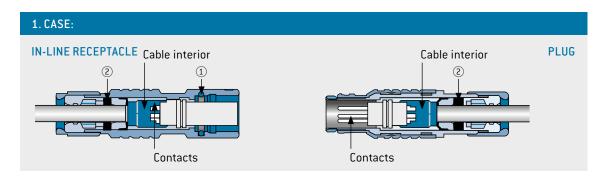
Acc. IEC 60529:2013 (VDE 0470-1:2014).

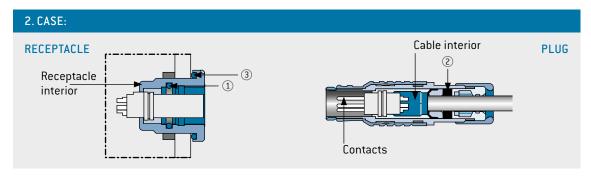
	Code letters		First code number			econd code nu	
(International Protection) (Degrees of protection against access to hazardous parts respectively against solid foreign objects)		(Degrees of protection against water)					
	IP		foreign objects j			5 	
Code			ess to hazardous parts /	Code Protection against harmful eff cts			
number	Protection	against ingre	ss of solid foreign objects	number		due to the ing	gress of water
0	No protection	100	No protection against contact / No protection against solid foreign objects	0	No protection against water		No protection against water
1	Protection against large foreign objects		Protection against contact with the back of the hand / Protection against solid foreign objects Ø ≥ 50 mm	1	Protection against dripping water		Protection against vertically falling waterdrops
2	Protection against medium-sized foreign objects		Protection against contact with the fingers / Protection against solid foreign objects Ø ≥ 12.5 mm	2	Protection against angular dripping water (from angles)		Protection against waterdrops falling at an angle (any angle up to 15° of the vertical)
3	Protection against small foreign objects		Protection against contact with tools/Protection against solid foreign objects Ø ≥ 2.5 mm	3	Protection against spray water		Protection against spray water (any angle up to 60° of the vertical)
4	Protection against granular foreign objects		Protection against contact with a wire / Protection against solid foreign objects $\emptyset \ge 1.0$ mm	4	Protection against splashing water		Protection against splashing water from any direction
5	Dustproof		Protection against contact with a wire/Protection against uncontrolled ingress of dust	5	Protection against water jet		Protection against water jet from any direction
6	Dustproof		Protection against contact with a wire / Complete protection against ingress of dust	6	Protection against power- ful water jet		Protection against powerful water jet from all directions
				7	Protection against the eff cts of temporary immersion in water		Protection against ingress of water negatively impacting the proper function by temporary submersion into water
				8	Protection against the eff cts of continuous immersion in water		Protection against ingress of quantities of water negatively impacting the proper function by continuous submersion into water
				9	Protection against high pressure water jet featuring high tempera- tures	↑	Protection against water from all directions characterized by high pressure and high temperatures

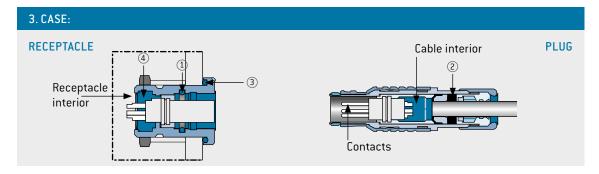
PRINCIPLE OF WATERTIGHTNESS WITH ODU MINI-SNAP®



ODU makes both IP 50 and IP 68 in the L and B series in the same diameter. For reasons of compatibility with the competition, ODU now offers the series K as well, which has a greater diameter than the non-watertight model (series L).







All IP 68 submersible ODU MINI-SNAP connectors have a rated water depth of 2 m (0.2 bar) for 24 hours in accordance with IEC 60529:2013 (VDE 0470-1:2014). A watertight connector requires a sealing in a cable collet system.

The sleeve must fit over the cable precisely. The cable jacket must be smooth, cylindrical and free of grooves. The connector should be encapsulated to make it watertight when not mated.

PROTECTION AGAINST WATER BY THE FOLLOWING SEALINGS¹

Ф		Mated		Unm	ated
Case	Termination	Tight	Position	Tight	Position
1	Cable interior	Yes	12	No	
2	Receptacle interior	Yes	123	No	
3	Receptacle interior	Yes	123	Yes	34

① 0-ring ② Elastic sealing² ③ 0-ring ④ Grouting

¹ The following applies to the contacts: the contacts are protected in cases 1, 2 and 3 when mated. When not mated, the contacts are only protected by a protective cover (see page 69 for series L, page 110 for series K and page 148 for series B) which must be removed before mating. ² The cable seal with elastic disks requires coordination with the cable. Decisive factors: Diameter tolerance, roundness, cable structure, cable jacket hardness.

HOUSING MATERIALS / SURFACES



Component	Material designation	Surface
Connector plug housing Back nut Decorative slotted mounting nut	Cu-alloy	Cr ¹
Cable collet EMI ring Half-shell Lock washer Nut Retainer Ring	Cu-alloy	Ni
Contact pin (solder/PCB) Contactsocket(solder/PCB) Contact pin (crimp) Contact socket (crimp)	Cu-alloy	Au

ODU MINI-SNAP connector plug housings are made of brass, nickel plated and then matt chrome plated. Nickel and black chrome plated connector plug housings are available upon request as special materials. The internal parts are made of nickel plated brass.

INSULATOR MATERIALS (COMPLIANT TO ROHS 2011/65/EU)

	Norm	Unit	PEEK
Dielectric strength	IEC 60243-1:2013 (VDE 0303-21:2014)	KV/mm	19
Operation temperature	ASTM D 149:2009	°C	-50/+250
Flammability rating	UL-94:2013	-	V-0
Comparative tracking index CTI	IEC 60112:2009 (VDE 0303-11:2010)		175

¹ Black chrome plated on request. Choice in the part number key, see page 39 (series L), page 88 (series K), page 125 (series B).

TERMINATION TECHNOLOGIES



Insulators with pin contacts fit into the receptacle (or in-line receptacle) as well as into the plug. The same applies to insulators with socket contacts. In general, insulators with socket contacts are installed in the live part (to provide protection from accidental touch).

The means of mounting the contacts in the insulator is important on account of the termination technologies. Termination technologies for ODU MINI-SNAP connectors include: soldering, crimping and PCB.



TERMINATION TECHNOLOGIES FOR TURNED CONTACTS

Solder termination

The contacts are mounted in the insulator before the single connectors are assembled. An insulator with pre-installed contacts is referred to as a contact insert.

Crimp termination

Here, the individual contact is connected to the individual wires via deformation in the termination area. Then the contacts are individually installed in the insulator. Accordingly, insulators and individual contacts — and not complete contact inserts — are supplied for the crimp termination. The contact processing for the production of connecting cables via crimping creates a secure, durable and corrosion-free contact. Cold compaction (crimping) compresses the conductor and contact material to the press points so as to form a gas-tight connection with tensile strength to fit the conductor material. 8-point deformation is generally used for turned crimp contacts.

PCB termination

This is only used in the receptacle if the receptacle is to be mounted directly on a printed circuit board (PCB). Further information is available upon request.

CONVERSIONS/AWG (AMERICAN WIRE GAUGE)



Circular wire						
AWG	Diam	neter	Cross- section	Weight	Max. resist- ance	
	Inch	mm	mm²	kg/km	Ω/km	
10 (1)	0.1019	2.590	5.26	46.77	3.45	
10 (37/26)	0.1150	2.921	4.74	42.10	4.13	
12 (1)	0.0808	2.050	3.31	29.41	5.45	
12 (19/25)	0.0930	2.362	3.08	27.36	6.14	
12 (37/28)	0.0910	2.311	2.97	26.45	6.36	
14 (1)	0.0641	1.630	2.08	18.51	8.79	
14 (19/27)	0.0730	1.854	1.94	17.23	9.94	
14 (37/30)	0.0735	1.867	2.08	18.870	10.50	
16 (1)	0.0508	1.290	1.31	11.625	13.94	
16 (19/29)	0.0590	1.499	1.23	10.928	15.70	
18 (1)	0.0403	1.020	0.823	7.316	22.18	
18 (19/30)	0.0052	1.321	0.963	8.564	20.40	
20 (1)	0.0320	0.813	0.519	4.613	35.10	
20 (7/28)	0.0390	0.991	0.563	5.003	34.10	
20 (19/32)	0.0420	1.067	0,616	5.473	32.00	
22 (1)	0.0253	0.643	0,324	2.883	57.70	
22 (7/30)	0.0288	0.732	0,324	2.965	54.80	
22 (19/34)	0.0330	0.838	0.382	3.395	51.80	
24 [1]	0.0201	0.511	0.205	1.820	91.20	
24 (7/32)	0.0250	0.635	0.227	2.016	86.00	
24 [19/36]	0.0270	0.686	0.241	2.145	83.30	
26 (1)	0.0159	0.404	0.128	1.139	147.00	
26 (7/34)	0.0200	0.508	0.141	1.251	140.00	
26 (19/38)	0.0220	0.559	0.154	1,370	131.00	
28 (1)	0.0126	0.320	0.0804	0.715	231.00	
28 (7/36)	0.0160	0.406	0.0889	0.790	224.00	
28 (19/40)	0.0170	0.432	0.0925	0.823	207.00	
30 (1)	0.0100	0.254	0.0507	0.450	374.00	
30 (7/38)	0.0130	0.330	0.0568	0.505	354.00	
30 (19/42)	0.0123	0.312	0.0720	0.622	310.00	
32 (1)	0.0080	0.203	0.0324	0.288	561.00	
32 (7/40)	0.0110	0.279	0.0341	0.303	597.10	
32 (19/44)	0.0100	0.254	0.0440	0.356	492.00	
34 (1)	0.0063	0.160	0.0201	0.179	951.00	
34 (7/42)	0.0070	0.180	0.0222	0.197	1,491.00	
36 (1)	0.0050	0.127	0.0127	0.1126	1,519.00	
36 (7/44)	0.0060	0.150	0.0142	0.1263	1,322.00	

The American Wire Gauge (AWG) is based on the principle that the cross-section of the wire changes by 26% from one gauge number to the next. The AWG numbers decrease as the wire diameter increases, while the AWG numbers increase as the wire diameter decreases. This only applies to solid wire.

However, stranded wire is predominately used in practice. This has the advantage of a longer service life under bending and vibration as well as greater flexibility in comparison with solid wire.

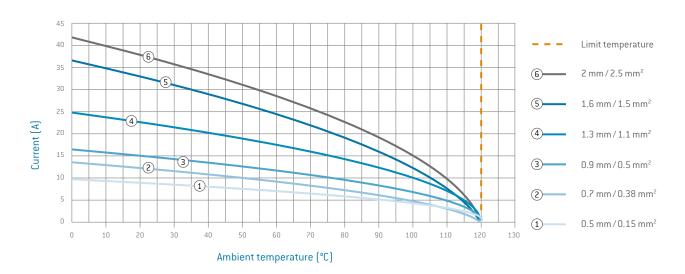
Stranded wires are made of multiple, smaller-gauge wires (higher AWG number). The stranded wire then receives the AWG numbers of a solid wire with the next closest cross-section to that of the stranded wire. In this case, the cross-section of the stranded wire refers to the sum of the copper cross-sections of the individual wires.

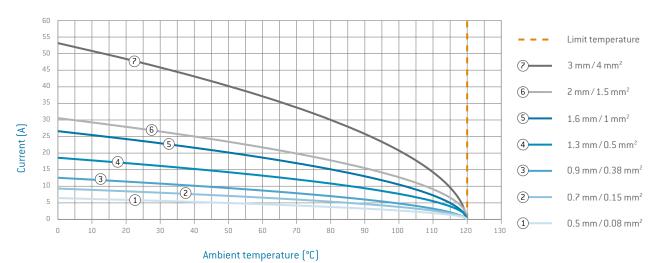
Accordingly, strands with the same AWG number but different numbers of wires differ in cross-section. For instance, an AWG 20 strand of 7 AWG 28 wires has a cross-section of 0.563 mm², while an AWG 20 strand of 19 AWG 32 wires has a cross-section of 0.616 mm².

Source: ASTM



Nominal single contact current load for pin / slotted socket (nominal diameter 0.5 mm - 2.0 mm)





UPPER LIMIT TEMPERATURE OF STANDARD CONTACTS: +120 °C

The wire cross-section shown in the legend was connected as test cable. In the case of multi-position connectors and cables, the heating is greater than it is with individual contacts. For that reason, it is calculated with a reduction factor.

For connectors, the reduction factors for multi-core cables pursuant to VDE 0298-4:2013 are applied. The reduction factor is factored in at 5 live wires and up.

DERATING CURVE

The corrected current-carrying capacity curve, derived from the base curve determined [0.8 x measured current]. It factors in manufacturing tolerances as well as uncertainties in temperature measurement and measurement arrangement. See derating measurement method.

RATED CURRENT (NOMINAL CURRENT)

The metrologically determined current which is permitted to flow continuously through all contacts at the same time and will increase the contact temperature by 45 Kelvin. The amperage is determined according to the derating measurement method [IEC 60512-5-2:2002 [DIN EN 60512-5-2:2003] and derived from the derating curve.

DERATING FACTOR

Number of loaded wires	Derating factor
5	0.75
7	0.65
10	0.55
14	0.5
19	0.45
24	0.4

OPERATING VOLTAGE

Acc. SAE AS 13441:2004 method 3001.1



The values specified in the catalog correspond to SAE AS 13441:2004 method 3001.1. The table values were determined according to EIA 364-20E:2015. The inserts were tested while mated, and the test current was applied to the pin insert.

75 % of the dielectric withstanding voltage is used for the further calculation. The operating voltage is 1/3 of this value.

All tests were conducted at normal indoor climate and apply up to an altitude of 2,000 m. If there are any deviations, the reduction factors are to be factored in according to the applicable standards. Test voltage: Dielectric withstanding voltage \times 0.75 \times 0.33

ATTENTION:

With certain applications, the safety requirements for electrical devices are very strict in terms of operating voltage. In such cases, the operating voltage is defi ed according to the clearance and creepage distances between parts which could be touched.

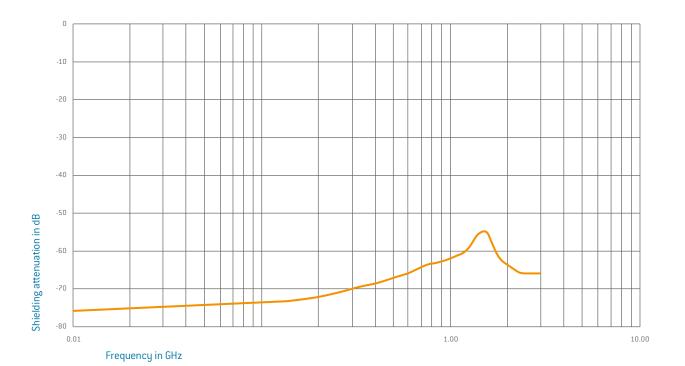
When selecting such a connector, please contact us and let us know the safety standard which the product must meet.

Test voltage: Dielectric withstanding voltage \times 0.75

Operating voltage: Dielectric withstanding voltage \times 0.75 \times 0.33

ELECTRO MAGNETIC COMPATIBILITY (EMC)

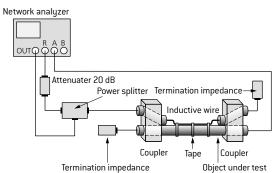




Electromagnetic compatibility (EMC) concerns more than just devices and electronic circuits. In the age of networks and data communication, connecting elements such as cables and connectors are also very important. Interference signals penetrating the connector from outside corrupt data signals and can cause significant system malfunctions. This can be reliably avoided with high-grade shielding for the cables and connectors. In order to give our customers certainty when using ODU MINI-SNAP connectors, we've had a size 3 connector measured by an accredited EMC laboratory to determine its EMC quality. Since the sizes 0, 1 and 2 are identical to this connector in structure, just proportionally reduced in size, the values for shielding attenuation are the same.

The measurement was conducted according to the injection or parallel wire method pursuant to VG 95214-11:2002. The connector pair is connected to the receiver of a network analyzer on one end, while the other end receives an adjusted termination resistor. The injection wire is attached as closely as possible along the connector pair. A flat cable is usually used here, since an optimum adjustment can be achieved by attaching more or fewer wires. High-frequency signals in the 10 kHz to 3 GHz range are now fed in through the injection wire. The network analyzer measures the energy irradiated through the connector plug housing and into the connector, providing a shielding attenuation factor as the logarithmic performance ratio AT in dB. The important thing with this method is that all supply lines (especially the ones to the connector pair) must be very well shielded so that no interference signals can penetrate the measurement system and corrupt the measured values. This provides the shielding attenuation in dB as a curve over the logarithmically applied frequency.

Users frequently demand a shielding attenuation better than -55 dB (based on a requirement of Deutsche Post). It is clear that our connector meets this requirement over the entire measurement range.

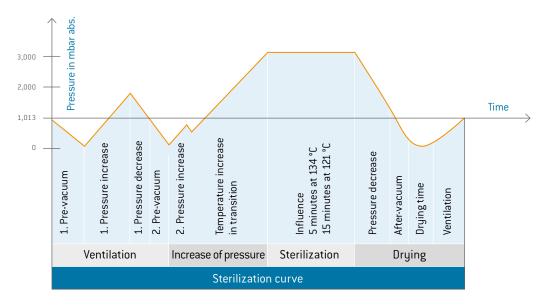


AUTOCLAVING OF ODU MINI-SNAP®



We can also provide ODU MINI-SNAP connectors for the following sterilization procedures upon request: steam sterilization via pre-vacuum or gravity method. The connectors are tested in autoclaves for 500 cycles at $134\,^{\circ}\text{C}$ in accordance with DIN EN 13060:2015.

Please consult our technical team for the further sterilization procedure.



TEST STANDARD

In terms of the quality approval, sizes 0 and 3 were subjected to environmental and mechanical tests pursuant to MIL and passed them flawlessly.

Defin tion	Standard
High temperature	MIL-STD-810G w/Change 1:2014 method 501.6
Low temperature	MIL-STD-810G w/Change 1:2014 method 502.6
Temperature shock	MIL-STD-810G w/Change 1:2014 method 503.6
Humidity	MIL-STD-810G w/Change 1:2014 method 507.6
Salt fog	MIL-STD-810G w/Change 1:2014 method 509.6
Shock	MIL-STD-810G w/Change 1:2014 method 516.7
Vibration	MIL-STD-1344A method 2005.1 (IV)
Watertightness IP 68	IEC 60529:2013 (VDE 0470-1:2014)

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AMBIENT TEMPERATURE

Temperature of the air or other medium in which a piece of equipment is intended to be used. (IEC 44/709/CDV:2014 (VDE 0113-1:2014).

AUTOCLAVABILITY

See page 170.

AWG

American Wire Gauge - see page 166.

BASE CURVE

A current-carrying capacity curve metrologically determined according to the method described in IEC 60512-5-2:2002 (DIN EN 60512-5-2:2003) depending on the permissible limit temperature of the materials.

CHEMICAL RESISTANCE

Many secondary processing procedures use adhesives, cleaning agents or other chemicals on our products. Contact with unsuitable chemicals may have an adverse effect on the mechanical and electrical properties of the insulation and housing materials which specified properties may not be able to withstand. Please observe our processing suggestions and technical instructions in this catalog.

CLEARANCE DISTANCE

The shortest distance in the air between two conductive parts.

CONNECTORS

Also known as connectors without contact rating (COC): (IEC 61984:2008 (VDE 0627:2009). An element which enables electrical conductors to be connected and is intended to create and/or separate connections with a suitable counterpart.

CONNECTOR WITHOUT BREAKTING CAPACITY (COC)

Connector which is not deemed to be engaged or disengaged in normal use when live under load.

CONTACT RESISTANCE

Total resistance value measured from terminal to terminal. In this case, the resistance is significantly lower than the contact resistance. The specifications are average values.

CORES

Electrical conductor, solid wire or multi-wire strand, with insulation as well as any conductive layers. Cables or leads may have one or more cores.

CREEPAGE DISTANCES

The shortest distance between two conductive parts along the surface of a solid insulation material. This factors in all elevations and recesses in the insulator, as long as defi ed minimum dimensions are on hand.

CRIMP BARREL

A terminal sleeve which can accommodate one or more conductors and be crimped by a crimping tool.

CRIMP CONNECTION (CRIMP TERMINATION)

The permanent, non-detachable and solder-free mounting of a contact to a conductor via deforming or shaping under pressure to make a good electrical and mechanical connection. Executed with crimping tool, press or automatic crimping machine (see page 156).

CRIMPING AREA

The specified area of the crimp barrel in which the crimp termination is executed by means of deforming or shaping the barrel under pressure around the conductor.

DEGREE OF POLLUTION

The effect of pollution is factored in as degree of pollution when measuring clearance and creepage distances. Four degrees of pollution are defi ed for the micro-environment: IEC 60664-1:2007 (VDE 0110-1:2008).

DELIVERY FORM

Connectors can be delivered in assembled form or as individual parts.

DERATING CURVE

See page 167.

DERATING MEASUREMENT METHOD IEC 60512-5-2:2002 (DIN EN 60512-5-2:2003)

Measurement method to determine the current-carrying capacity of connectors in consideration of the maximum permissible limit temperature (see page $\underline{167}$).

TECHNICAL TERMS



FIXED CONNECTORS

Intended for mounting on a fi ed surface such as a frame, dock, device or wall (with ODU also receptacle or panel-mounted plug).

FREE CONNECTORS

Intended for mounting on free ends of mobile leads and cables (with ODU also connectors, plugs, in-line receptacles).

INSULATOR

Part of a connector which separates conductive parts with different potentials from one another; usually identical to the contact carrier.

KEYING (ORIENTATION)

Arrangement with which differing polarization of otherwise identical connectors prevents interchangeability. This is a good idea if two or more identical connectors are attached to the same device (see also compatible connectors, see pages 39, 88, 125).

LOWERMOST LIMIT TEMPERATURE

The lowest permissible temperature at which a connector may be operated. At ODU MINI-SNAP, it amounts to -40 °C.

MATING AND DEMATING FORCE

The force required to fully insert or withdraw pluggable elements without the inflence of a coupling or locking device.

MATING CYCLES

Mechanical actuation of connectors and plug devices via push and pull action. A mating cycle consists of one insertion and withdrawal action. ODU's standard value for the ODU MINI-SNAP series is 5,000 mating cycles.

MAX. CONTINUOUS CURRENT

The metrologically determined amperage at room temperature (approx. 20 °C) which increases the contact temperature to the limit temperature. The values specified in the catalog apply to either individual contacts or completely assembled inserts / modules, as indicated.

NOMINAL SINGLE CONTACT CURRENT LOAD

The current-carrying capacity which each individual contact can be loaded with on its own (see page 167).

NOMINAL VOLTAGE

The voltage which the manufacturer specifies for a connector and relates to the operating and performance features.

OPERATING TEMPERATURE FOR ODU MINI-SNAP

Range between the uppermost and lowermost temperature limits. $-40 \,^{\circ}\text{C}$ to $+120 \,^{\circ}\text{C}$ (see page 15).

OPERATING VOLTAGE

The nominal voltage of the power source for which the connector is being used. The operating voltage may not be higher than the nominal voltage of the connector.

PCB (A.K.A. "PRINTED CIRCUIT BOARD")

A PCB is a carrier for electronic components. It serves the purposes of mechanical mounting and electrical connection.

PCB TERMINATION

Production of a conductive connection between the PCB and an element in through-hole assembly, THT (through-hole technology).

RATED CURRENT (NOMINAL CURRENT)

See page 167.

RATED VOLTAGE

According to IEC 60664-1:2007 (VDE 0110-1:2008) standard "Value of a voltage which is specified by the manufacturer for a component, device or operating medium and relates to the operating and performance features."

SOLDER CONNECTION (SOLDER TERMINATION)

Termination technology in which a molten additional metal (solder) with a lower melting point than the base materials to be connected is used to attach two metallic materials to one another.

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TERMINATION CROSS-SECTION

The specified cross-sections correspond to a "fi e-wire" conductor structure pursuant to IEC 60228:2004 (VDE 0295:2005; Class 5) or a "fi e-wire" conductor structure (7/19 wire) according to AWG (ASTM B258-14).

TERMINATION TECHNOLOGIES

Methods for connecting the leads to the electro-mechanical element, such as solder-free connections pursuant to IEC 60352 (DIN EN 60352): crimp, screw connection etc. or soldering connection (see page 165).

TEST VOLTAGE

The voltage which a conductor can withstand under defi ed conditions without dielectric breakdown or flashover.

TIGHTNESS IEC 60529:2013 (VDE 0470-1:2014)

See protection classes on page 162.

UPPERMOST LIMIT TEMPERATURE

The maximum permissible temperature at which a connector may be operated. It includes contact heating through current-carrying capacity.

With ODU MINI-SNAP Standard TURNTAC contacts, it amounts to +120 °C. Please consult ODU for high-temperature applications.

WIRE

Wires (solid conductors) are available with an insulator sleeve and/or electrical shielding. Cables or conductors may be made up of one or more wires.

GENERAL NOTE

The connectors listed in this catalog are intended for use in high voltage and frequency ranges. Suitable precautionary measures must be taken to ensure that people do not come into contact with live conductors during installation and operation. All entries in this catalog were thoroughly reviewed before printing. ODU reserves the right to make changes based on the current state of knowledge without prior notice without being obliged to provide replacement deliveries or refi ements of older designs.



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